

# 8-bit Microcontroller

CMOS

## F<sup>2</sup>MC-8FX MB95200H/210H Series

**MB95F204H/F204K/F203H/F203K/F202H/F202K**  
**MB95F214H/F214K/F213H/F213K/F212H/F212K**

### ■ DESCRIPTION

MB95200H/210H is a series of general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers of this series contain a variety of peripheral resources.

Note: F<sup>2</sup>MC is the abbreviation of FUJITSU Flexible Microcontroller.

### ■ FEATURES

- F<sup>2</sup>MC-8FX CPU core
  - Instruction set optimized for controllers
    - Multiplication and division instructions
    - 16-bit arithmetic operations
    - Bit test branch instructions
    - Bit manipulation instructions, etc.
- Clock
  - Selectable main clock source
    - Main OSC clock (up to 16.25 MHz, maximum machine clock frequency: 8.125 MHz)
    - External clock (up to 32.5 MHz, maximum machine clock frequency: 16.25 MHz)
    - Main internal CR clock (1/8/10/12.5 MHz  $\pm$  2%, maximum machine clock frequency: 12.5 MHz)
  - Selectable subclock source
    - Sub-OSC clock (32.768 kHz)
    - External clock (32.768 kHz)
    - Sub-internal CR clock (typ: 100 kHz, min: 50 kHz, max: 200 kHz)

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The information for microcontroller supports is shown in the following homepage.  
Be sure to refer to the "Check Sheet" for the latest cautions on development.

### "Check Sheet" is seen at the following support page

"Check Sheet" lists the minimal requirement items to be checked to prevent problems beforehand in system development.

<http://edevic.fujitsu.com/micom/en-support/>

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- Timer
  - 8/16-bit composite timer
  - Timebase timer
  - Watch prescaler
- LIN-UART (**MB95F204H/F204K/F203H/F203K/F202H/F202K**)
  - Full duplex double buffer
  - Capable of clock-synchronized serial data transfer and clock-asynchronized serial data transfer
- External interrupt
  - Interrupt by edge detection (rising edge, falling edge, and both edges can be selected)
  - Can be used to wake up the device from different low-power consumption (standby) modes
- 8/10-bit A/D converter
  - 8-bit or 10-bit resolution can be selected.
- Low power consumption (standby) mode
  - Stop mode
  - Sleep mode
  - Watch mode
  - Timebase timer mode
- I/O port (max: 17) (**MB95F204K/F203K/F202K**)
  - General-purpose I/O ports (max):  
CMOS I/O: 15, N-ch open drain: 2
- I/O port (max: 16) (**MB95F204H/F203H/F202H**)
  - General-purpose I/O ports (max):  
CMOS I/O: 15, N-ch open drain: 1
- I/O port (max: 5) (**MB95F214K/F213K/F212K**)
  - General-purpose I/O ports (max):  
CMOS I/O: 3, N-ch open drain: 2
- I/O port (max: 4) (**MB95F214H/F213H/F212H**)
  - General-purpose I/O ports (max):  
CMOS I/O: 3, N-ch open drain: 1
- On-chip debug
  - 1-wire serial control
  - Serial writing supported (asynchronous mode)
- Hardware/software watchdog timer
  - Built-in hardware watchdog timer
- Low-voltage detection reset circuit
  - Built-in low-voltage detector
- Clock supervisor counter
  - Built-in clock supervisor counter function
- Programmable port input voltage level
  - CMOS input level / hysteresis input level
- Flash memory security function
  - Protects the contents of flash memory

■ PRODUCT LINE-UP

| Part number                      | MB95 F204H  | MB95 F203H | MB95 F202H | MB95 F204K                               | MB95 F203K | MB95 F202K | MB95 F214H  | MB95 F213H | MB95 F212H | MB95 F214K                             | MB95 F213K | MB95 F212K |
|----------------------------------|---|------------|------------|--|------------|------------|---|------------|------------|--|------------|------------|
| Parameter                        |   |            |            |  |            |            |   |            |            |  |            |            |
| Type                             | Flash memory product  |            |            |  |            |            |   |            |            |  |            |            |
| Clock supervisor counter         | It supervises the main clock oscillation.   |            |            |  |            |            |   |            |            |  |            |            |
| ROM capacity                     | 16 KB   | 8 KB       | 4 KB       | 16 KB                                    | 8 KB       | 4 KB       | 16 KB   | 8 KB       | 4 KB       | 16 KB                                  | 8 KB       | 4 KB       |
| RAM capacity                     | 496 B   | 496 B      | 240 B      | 496 B                                    | 496 B      | 240 B      | 496 B   | 496 B      | 240 B      | 496 B                                  | 496 B      | 240 B      |
| Low-voltage detection reset      | No  |            |            | Yes                                      |            |            | No  |            |            | Yes                                    |            |            |
| Reset input                      | Dedicated   |            |            | Software select                          |            |            | Dedicated   |            |            | Software select                        |            |            |
| CPU functions                    | Number of basic instructions : 136<br>Instruction bit length : 8 bits<br>Instruction length : 1 to 3 bytes<br>Data bit length : 1, 8, and 16 bits<br>Minimum instruction execution time : 61.5 ns (with machine clock = 16.25 MHz)<br>Interrupt processing time : 0.6 μs (with machine clock = 16.25 MHz) |            |            |  |            |            |   |            |            |  |            |            |
| General-purpose I/O              | I/O ports (max): 16<br>CMOS: 15, N-ch: 1  |            |            | I/O ports (max): 17<br>CMOS: 15, N-ch: 2 |            |            | I/O ports (max): 4<br>CMOS: 3, N-ch: 1  |            |            | I/O ports (max): 5<br>CMOS: 3, N-ch: 2 |            |            |
| Timebase timer                   | Interrupt cycle : 0.256 ms - 8.3 s (when external clock = 4 MHz)  |            |            |  |            |            |   |            |            |  |            |            |
| Hardware/software watchdog timer | Reset generation cycle<br>Main oscillation clock at 10 MHz : 105 ms (min)<br>The sub-internal CR clock can be used as the source clock of the hardware watchdog.  |            |            |  |            |            |   |            |            |  |            |            |
| Wild register                    | It can be used to replace three bytes of data.  |            |            |  |            |            |   |            |            |  |            |            |
| LIN-UART                         | A wide range of communication speed can be selected by a dedicated reload timer.<br>It has a full duplex double buffer.<br>Clock-synchronized serial data transfer and clock-asynchronized serial data transfer is enabled.<br>The LIN function can be used as a LIN master or a LIN slave.               |            |            |  |            |            | No LIN-UART   |            |            |  |            |            |
| 8/10-bit A/D converter           | 6 ch.<br>8-bit or 10-bit resolution can be selected.  |            |            |  |            |            | 2 ch.   |            |            |  |            |            |
| 8/16-bit composite timer         | 2 ch.   |            |            |  |            |            | 1 ch.<br>The timer can be configured as an "8-bit timer x 2 channels" or a "16-bit timer x 1 channel".<br>It has built-in timer function, PWC function, PWM function and input capture function.<br>Count clock: it can be selected from internal clocks (seven types) and external clocks.<br>It can output square wave. |            |            |  |            |            |
| External interrupt               | 6 ch.   |            |            |  |            |            | 2 ch.<br>Interrupt by edge detection (rising edge, falling edge, or both edges can be selected.)<br>It can be used to wake up the device from standby modes.  |            |            |  |            |            |
| On-chip debug                    | 1-wire serial control<br>It supports serial writing. (asynchronous mode)  |            |            |  |            |            |   |            |            |  |            |            |

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| Part number                            | MB95<br>F204H   | MB95<br>F203H | MB95<br>F202H | MB95<br>F204K | MB95<br>F203K | MB95<br>F202K | MB95<br>F214H  | MB95<br>F213H | MB95<br>F212H | MB95<br>F214K | MB95<br>F213K | MB95<br>F212K |
|--|---|---------------|---------------|---------------|---------------|---------------|----------------|---------------|---------------|---------------|---------------|---------------|
| Parameter                              |   |               |               |               |               |               |                |               |               |               |               |               |
| Watch prescaler                        | Eight different time intervals can be selected.   |               |               |               |               |               |                |               |               |               |               |               |
| Flash memory                           | It supports automatic programming, Embedded Algorithm, write/erase/erase-suspend/resume commands.<br>It has a flag indicating the completion of the operation of Embedded Algorithm.<br>Number of write/erase cycles (min): 100000<br>Data retention time: 20 years<br>For write/erase, external Vpp(+10 V) input is required.<br>Flash Security Feature for protecting the contents of the flash |               |               |               |               |               |                |               |               |               |               |               |
| Standby mode                           | Sleep mode, stop mode, watch mode, timebase timer mode  |               |               |               |               |               |                |               |               |               |               |               |
| Package (Width, Length, Height, Pitch) | SDIP-24<br>SOP-20   |               |               |               |               |               | DIP-8<br>SOP-8 |               |               |               |               |               |

■ PACKAGES AND CORRESPONDING PRODUCTS

| Part number / Package | MB95 F204H | MB95 F203H | MB95 F202H | MB95 F204K | MB95 F203K | MB95 F202K | MB95 F214H | MB95 F213H | MB95 F212H | MB95 F214K | MB95 F213K | MB95 F212K |
|-----------------------|------------|------------|------------|------------|------------|------------|------------|------------|------------|------------|------------|------------|
| 24-pin plastic SDIP   | ○          | ○          | ○          | ○          | ○          | ○          | X          | X          | X          | X          | X          | X          |
| 20-pin plastic SOP    | ○          | ○          | ○          | ○          | ○          | ○          | X          | X          | X          | X          | X          | X          |
| 8-pin plastic DIP     | X          | X          | X          | X          | X          | X          | ○          | ○          | ○          | ○          | ○          | ○          |
| 8-pin plastic SOP     | X          | X          | X          | X          | X          | X          | ○          | ○          | ○          | ○          | ○          | ○          |

○ : Available  
 X : Unavailable

## ■ DIFFERENCES AMONG PRODUCTS AND NOTES ON PRODUCT SELECTION

- Current consumption

When using the on-chip debug function, take account of the current consumption of flash erase/program.

For details of current consumption, see "■ ELECTRICAL CHARACTERISTICS".

- Package

For details of information on each package, see "■ PACKAGES AND CORRESPONDING PRODUCTS" and "■ PACKAGE DIMENSION".

- Operating voltage

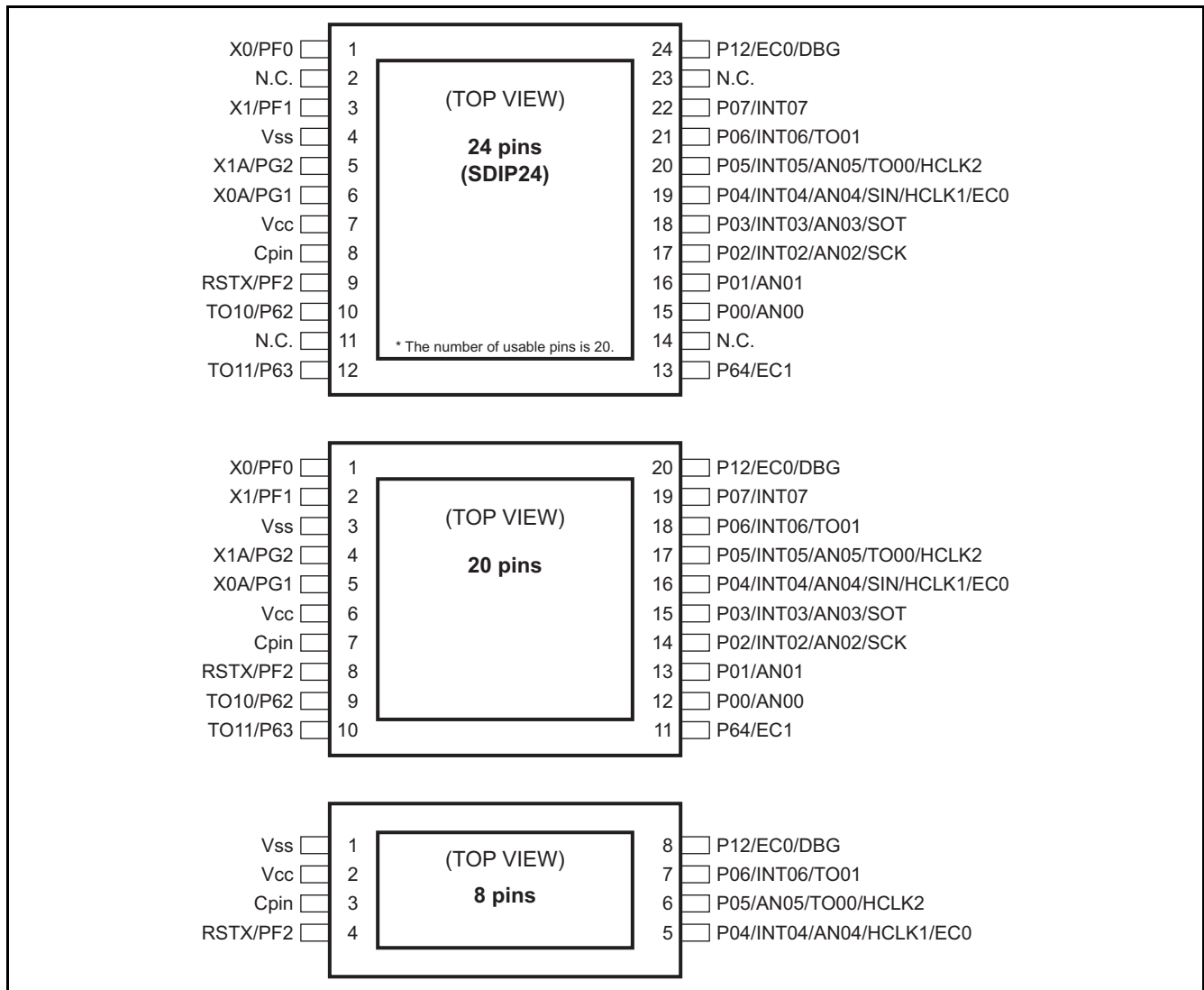
The operating voltage varies, depending on whether the on-chip debug function is used or not.

For details of the operating voltage, see "■ ELECTRICAL CHARACTERISTICS".

- On-chip debug function

The on-chip debug function requires that  $V_{CC}$ ,  $V_{SS}$  and 1 serial-wire be connected to an evaluation tool. In addition, if the flash memory data has to be updated, the RSTX/PF2 pin must also be connected to the same evaluation tool.

■ PIN ASSIGNMENT



## ■ PIN DESCRIPTION (MB95200H Series)

| Pin no. | Pin name                         | I/O circuit type* | Function  |
|---------|----------------------------------|-------------------|---|
| 1       | PF0/X0                           | B                 | General-purpose I/O port<br>This pin is also used as the main clock input oscillation pin.  |
| 2       | PF1/X1                           | B                 | General-purpose I/O port<br>This pin is also used as the main clock input/output oscillation pin.   |
| 3       | V <sub>SS</sub>                  | —                 | Power supply pin (GND)  |
| 4       | PG2/X1A                          | C                 | General-purpose I/O port<br>This pin is also used as the subclock input/output oscillation pin.   |
| 5       | PG1/X0A                          | C                 | General-purpose I/O port<br>This pin is also used as the subclock input oscillation pin.  |
| 6       | V <sub>CC</sub>                  | —                 | Power supply pin  |
| 7       | Cpin                             | —                 | Capacitor connection pin  |
| 8       | PF2/RSTX                         | A                 | General-purpose I/O port<br>This pin is also used as a reset pin.<br>This pin is a dedicated reset pin in MB95F204H/F203H/F202H.  |
| 9       | P62/TO10                         | D                 | General-purpose I/O port<br>High-current port<br>This pin is also used as the 8/16-bit composite timer ch. 1 output.  |
| 10      | P63/TO11                         | D                 | General-purpose I/O port<br>High-current port<br>This pin is also used as the 8/16-bit composite timer ch. 1 output.  |
| 11      | P64/EC1                          | D                 | General-purpose I/O port<br>This pin is also used as the 8/16-bit composite timer ch. 1 clock input.  |
| 12      | P00/AN00                         | E                 | General-purpose I/O port<br>This pin is also used as the A/D converter analog input.  |
| 13      | P01/AN01                         | E                 | General-purpose I/O port<br>This pin is also used as the A/D converter analog input.  |
| 14      | P02/INT02/AN02/<br>SCK           | E                 | General-purpose I/O port<br>This pin is also used as the external interrupt input.<br>This pin is also used as the A/D converter analog input.<br>This pin is also used as the LIN-UART clock I/O.  |
| 15      | P03/INT03/AN03/<br>SOT           | E                 | General-purpose I/O port<br>This pin is also used as the external interrupt input.<br>This pin is also used as the A/D converter analog input.<br>This pin is also used as the LIN-UART data output.  |
| 16      | P04/INT04/AN04/<br>SIN/HCLK1/EC0 | F                 | General-purpose I/O port<br>This pin is also used as the external interrupt input.<br>This pin is also used as the A/D converter analog input.<br>This pin is also used as the LIN-UART data input.<br>This pin is also used as the external clock input.<br>This pin is also used as the 8/16-bit composite timer ch. 0 clock input. |

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| Pin no. | Pin name                      | I/O circuit type* | Function   |
|---------|-------------------------------|-------------------|--|
| 17      | P05/INT05/AN05/<br>TO00/HCLK2 | E                 | General-purpose I/O port<br>High-current port<br>This pin is also used as the external interrupt input.<br>This pin is also used as the A/D converter analog input.<br>This pin is also used as the 8/16-bit composite timer ch. 0 output.<br>This pin is also used as the external clock input. |
| 18      | P06/INT06/TO01                | G                 | General-purpose I/O port<br>High-current port<br>This pin is also used as the external interrupt input.<br>This pin is also used as the 8/16-bit composite timer ch. 0 output.   |
| 19      | P07/INT07                     | G                 | General-purpose I/O port<br>This pin is also used as the external interrupt input.   |
| 20      | P12/EC0/DBG                   | H                 | General-purpose I/O port<br>This pin is also used as the DBG input pin.<br>This pin is also used as the 8/16-bit composite timer ch. 0 clock input.  |

\* : For the I/O circuit types, see "■ I/O CIRCUIT TYPE".

## ■ PIN DESCRIPTION (MB95210H Series)

| Pin no. | Pin name                     | I/O circuit type* | Function   |
|---------|------------------------------|-------------------|--|
| 1       | V <sub>SS</sub>              | —                 | Power supply pin (GND)   |
| 2       | V <sub>CC</sub>              | —                 | Power supply pin   |
| 3       | Cpin                         | —                 | Capacitor connection pin   |
| 4       | RSTX/PF2                     | A                 | General-purpose I/O port<br>This pin is also used as a reset pin.<br>This pin is a dedicated reset pin in MB95F214H/F213H/F212H.   |
| 5       | P04/INT04/AN04/<br>HCLK1/EC0 | E                 | General-purpose I/O port<br>This pin is also used as the external interrupt input.<br>This pin is also used as the A/D converter analog input.<br>This pin is also used as the external clock input.<br>This pin is also used as the 8/16-bit composite timer ch. 0 clock input. |
| 6       | P05/AN05/TO00/<br>HCLK2      | E                 | General-purpose I/O port<br>High-current port<br>This pin is also used as the A/D converter analog input.<br>This pin is also used as the 8/16-bit composite timer ch. 0 output.<br>This pin is also used as the external clock input.   |
| 7       | P06/INT06/TO01               | G                 | General-purpose I/O port<br>High-current port<br>This pin is also used as the external interrupt input.<br>This pin is also used as the 8/16-bit composite timer ch. 0 output.   |
| 8       | P12/EC0/DBG                  | H                 | General-purpose I/O port<br>This pin is also used as the DBG input pin.<br>This pin is also used as the 8/16-bit composite timer ch. 0 clock input.  |

\* : For the I/O circuit types, see "■ I/O CIRCUIT TYPE".

■ I/O CIRCUIT TYPE

| Type | Circuit | Remarks   |
|------|---------|---|
| A    |         | <ul style="list-style-type: none"> <li>• N-ch open drain output</li> <li>• Hysteresis input</li> <li>• Reset output</li> </ul>  |
| B    |         | <ul style="list-style-type: none"> <li>• Oscillation circuit</li> <li>• High-speed side</li> <li>Feedback resistance: approx. 1 MΩ</li> <li>• CMOS output</li> <li>• Hysteresis input</li> </ul>                                      |
| C    |         | <ul style="list-style-type: none"> <li>• Oscillation circuit</li> <li>• Low-speed side</li> <li>Feedback resistance: approx. 10 MΩ</li> <li>• CMOS output</li> <li>• Hysteresis input</li> <li>• Pull-up control available</li> </ul> |

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| Type | Circuit | Remarks  |
|------|---------|--|
| D    |         | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• Hysteresis input</li> </ul>  |
| E    |         | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• Hysteresis input</li> <li>• Pull-up control available</li> </ul>                       |
| F    |         | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• Hysteresis input</li> <li>• CMOS input</li> <li>• Pull-up control available</li> </ul> |
| G    |         | <ul style="list-style-type: none"> <li>• Hysteresis input</li> <li>• CMOS output</li> <li>• Pull-up control available</li> </ul>                       |
| H    |         | <ul style="list-style-type: none"> <li>• N-ch open drain output</li> <li>• Hysteresis input</li> </ul>   |

## ■ NOTES ON DEVICE HANDLING

- Preventing latch-ups

When using the device, ensure that the voltage applied does not exceed the maximum voltage rating.

In a CMOS IC, if a voltage higher than  $V_{CC}$  or a voltage lower than  $V_{SS}$  is applied to an input/output pin that is neither a medium-withstand voltage pin nor a high-withstand voltage pin, or if a voltage out of the rating range of power supply voltage mentioned in "1. Absolute Maximum Ratings" of ■ ELECTRICAL CHARACTERISTICS" is applied to the  $V_{CC}$  pin or the  $V_{SS}$  pin, a latch-up may occur.

When a latch-up occurs, power supply current increases significantly, which may cause a component to be thermally destroyed.

- Stabilizing supply voltage

Supply voltage must be stabilized.

A malfunction may occur when power supply voltage fluctuates rapidly even though the fluctuation is within the guaranteed operating range of the  $V_{CC}$  power supply voltage.

As a rule of voltage stabilization, suppress voltage fluctuation so that the fluctuation in  $V_{CC}$  ripple (p-p value) at the commercial frequency (50 Hz/60 Hz) does not exceed 10% of the standard  $V_{CC}$  value, and the transient fluctuation rate does not exceed 0.1 V/ms at a momentary fluctuation such as switching the power supply.

- Notes on using the external clock

When an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from subclock mode or stop mode.

## ■ PIN CONNECTION

- Treatment of unused pins

If an unused input pin is left unconnected, a component may be permanently damaged due to malfunctions or latch-ups. Always pull up or pull down an unused input pin through a resistor of at least 2 k $\Omega$ . Set an unused input/output pin to the output state and leave it unconnected, or set it to the input state and treat it the same as an unused input pin. If there is an unused output pin, leave it unconnected.

- Power supply pins

To reduce unnecessary electro-magnetic emission, prevent malfunctions of strobe signals due to an increase in the ground level, and conform to the total output current standard, always connect the  $V_{CC}$  pin and the  $V_{SS}$  pin to the power supply and ground outside the device. In addition, connect the current supply source to the  $V_{CC}$  pin and the  $V_{SS}$  pin with low impedance.

It is also advisable to connect a ceramic bypass capacitor of approximately 0.1  $\mu$ F between the  $V_{CC}$  pin and the  $V_{SS}$  pin at a location close to this device.

- DBG pin

Connect the DBG pin directly to an external pull-up resistor.

To prevent the device from unintentionally entering the debug mode due to noise, minimize the distance between the DBG pin and the  $V_{CC}$  or  $V_{SS}$  pin when designing the layout of the printed circuit board.

The DBG pin should not stay at "L" level after power-on until the reset output is released.

- RSTX pin

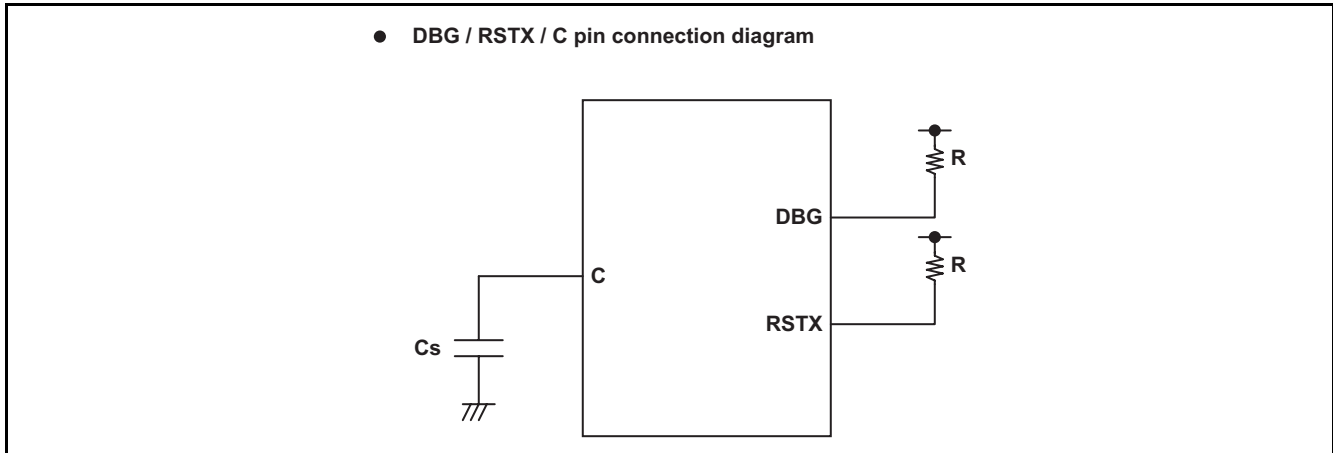
Connect the RSTX pin directly to an external pull-up resistor.

To prevent the device from unintentionally entering the reset mode due to noise, minimize the distance between the RSTX pin and the  $V_{CC}$  or  $V_{SS}$  pin when designing the layout of the printed circuit board.

The RSTX/PF2 pin functions as the reset input/output pin after power-on. In addition, the reset output can be enabled by the RSTOE bit of the SYSC register, and the reset input function or the general purpose I/O function can be selected by the RSTEN bit of the SYSC register.

- C pin

Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The bypass capacitor for the  $V_{CC}$  pin must have a capacitance larger than  $C_s$ . For the connection to a smoothing capacitor  $C_s$ , see the diagram below. To prevent the device from unintentionally entering an unknown mode due to noise, minimize the distance between the C pin and  $C_s$  and the distance between  $C_s$  and the  $V_{SS}$  pin when designing the layout of a printed circuit board.



**■ PROGRAMMING FLASH MEMORY MICROCONTROLLERS USING SERIAL PROGRAMMER****• Serial programmers and adapters supported**

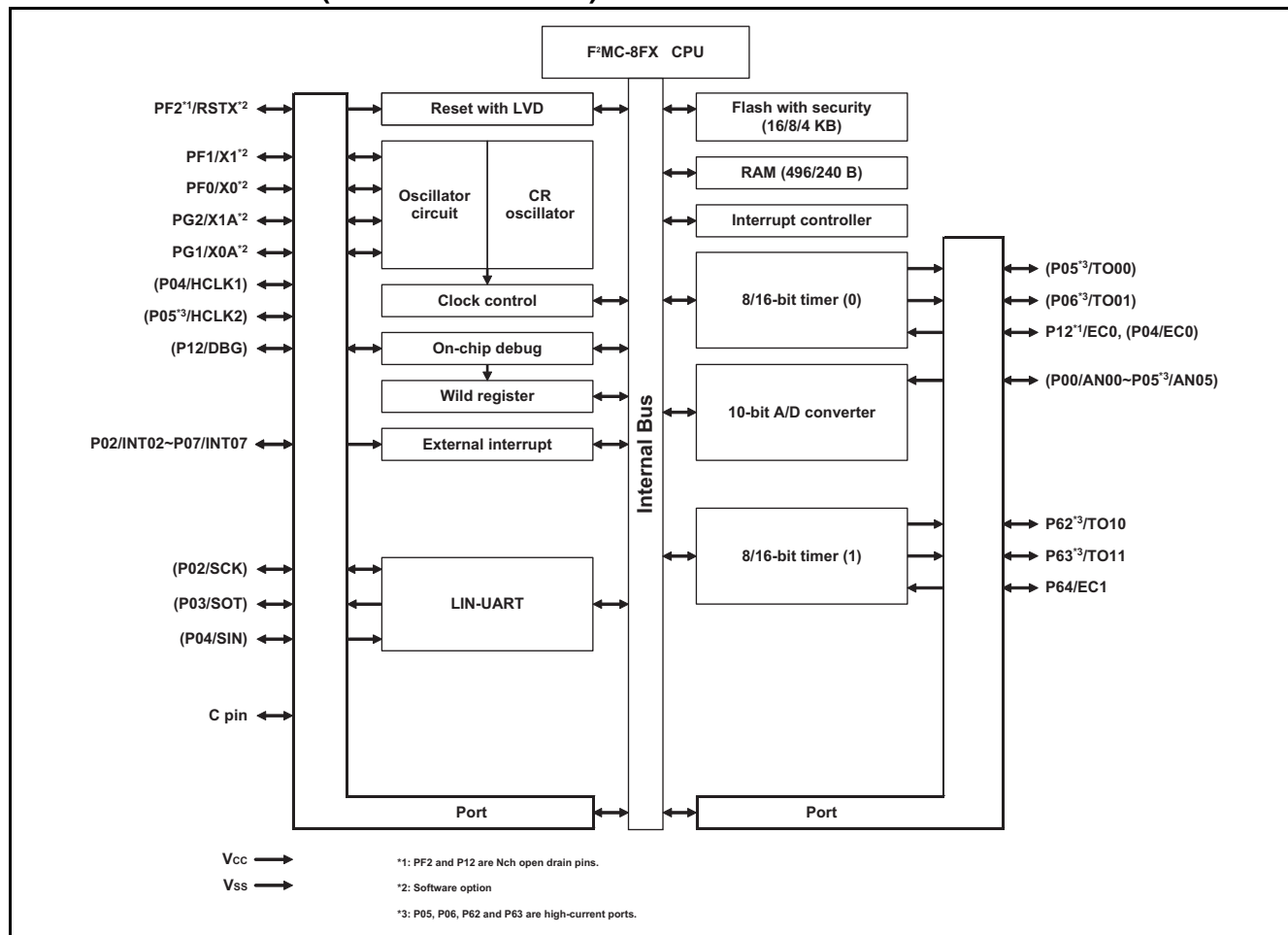
The following table shows serial programmers and adapters supported.

| Package | Applicable adapter model | Serial programmer |
|---------|--------------------------|-------------------|
| SDIP 24 | TBD                      | TBD               |
| SOP 20  | TBD                      | TBD               |
| DIP 8   | TBD                      | TBD               |
| SOP 8   | TBD                      | TBD               |

**• Programming method**

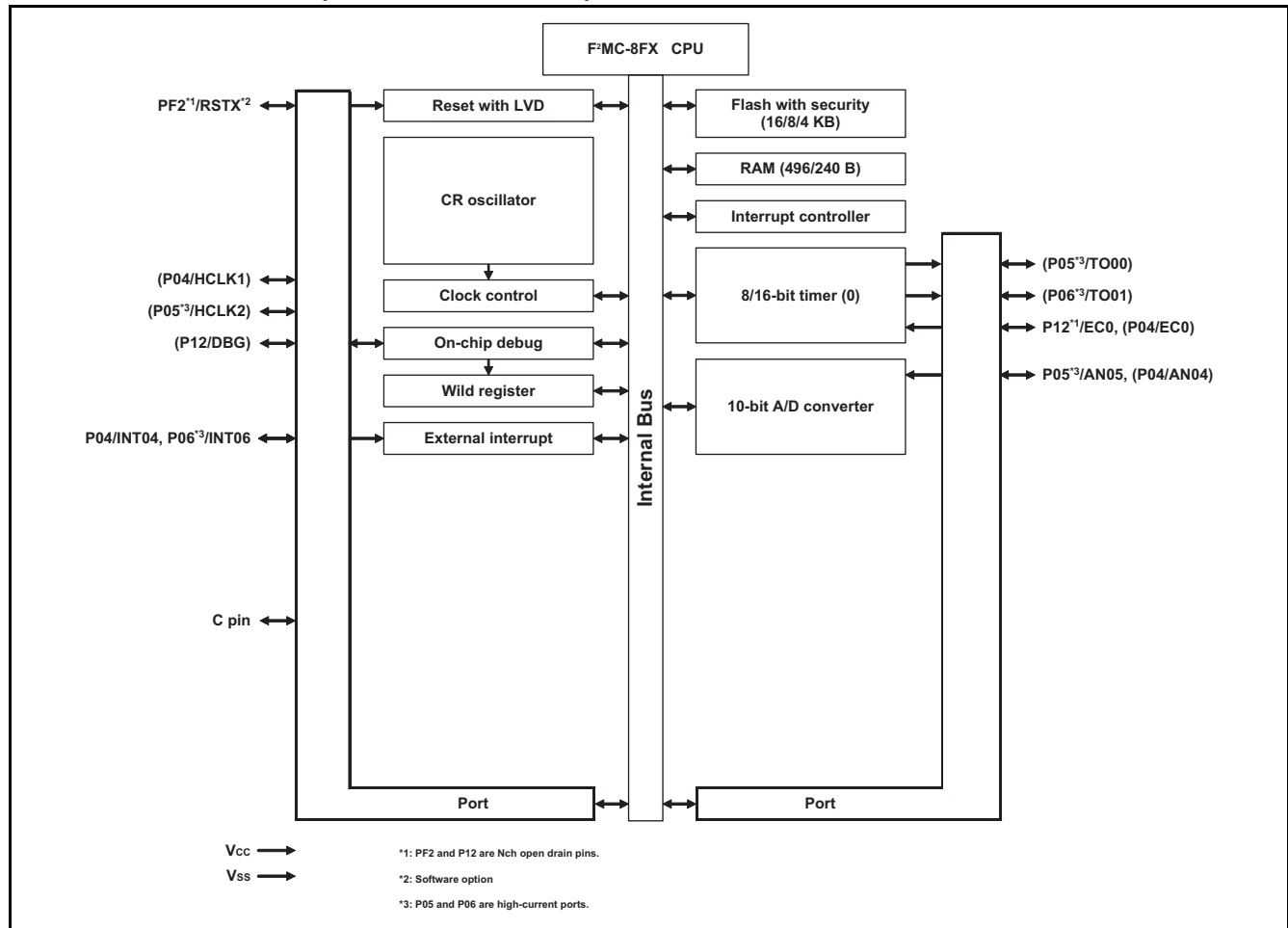
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## ■ BLOCK DIAGRAM (MB95200H Series)





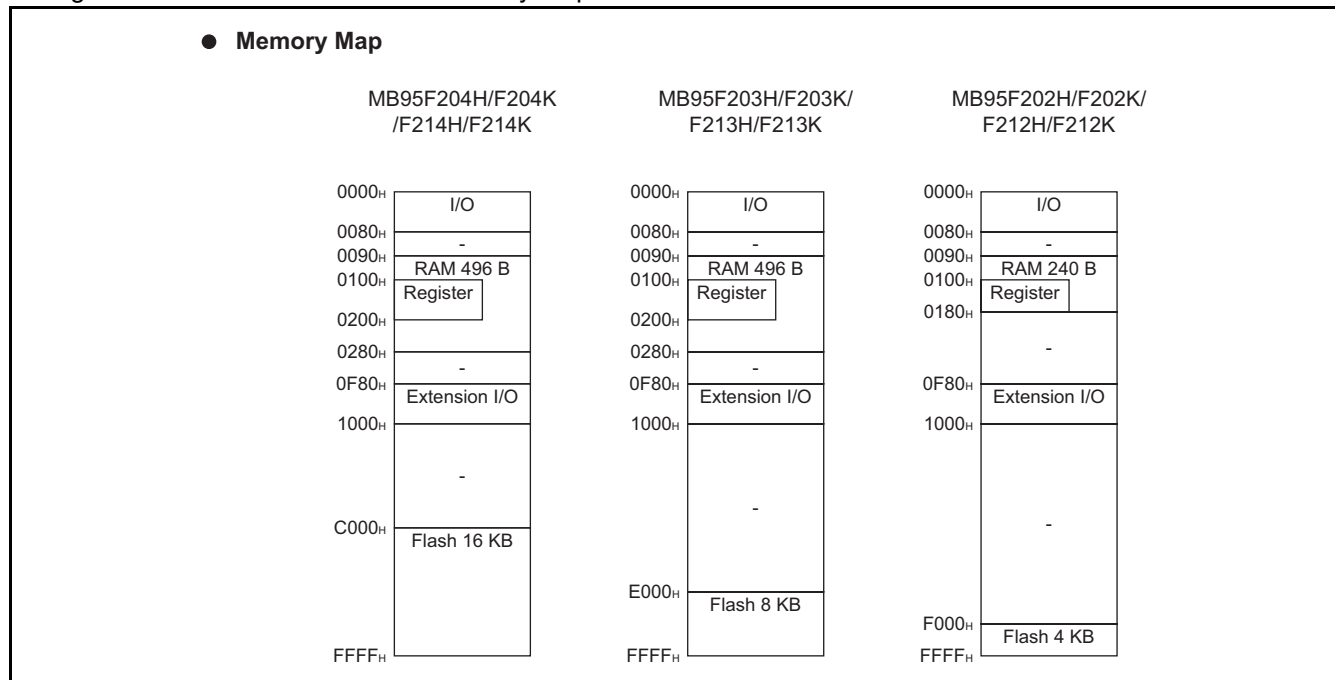
■ BLOCK DIAGRAM (MB95210H Series)



## ■ CPU CORE

### 1. Memory Space

The memory space of the MB95200H/210H Series is 64 KB in size, and consists of an I/O area, a data area, and a program area. The memory space includes areas intended for specific purposes such as general-purpose registers and a vector table. The memory maps of the MB95200H/210H Series are shown below.



## ■ I/O MAP (MB95200H Series)

| Address                                      | Register abbreviation | Register name   | R/W | Initial value         |
|--|-----------------------|---|-----|-----------------------|
| 0000 <sub>H</sub>                            | PDR0                  | Port 0 data register  | R/W | 00000000 <sub>B</sub> |
| 0001 <sub>H</sub>                            | DDR0                  | Port 0 direction register                                   | R/W | 00000000 <sub>B</sub> |
| 0002 <sub>H</sub>                            | PDR1                  | Port 1 data register  | R/W | 00000000 <sub>B</sub> |
| 0003 <sub>H</sub>                            | DDR1                  | Port 1 direction register                                   | R/W | 00000000 <sub>B</sub> |
| 0004 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0005 <sub>H</sub>                            | WATR                  | Oscillation stabilization wait time setting register        | R/W | 11111111 <sub>B</sub> |
| 0006 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0007 <sub>H</sub>                            | SYCC                  | System clock control register                               | R/W | XXXXXX11 <sub>B</sub> |
| 0008 <sub>H</sub>                            | STBC                  | Standby control register                                    | R/W | 00000XXX <sub>B</sub> |
| 0009 <sub>H</sub>                            | RSRR                  | Reset source register                                       | R   | XXXXXXXX <sub>B</sub> |
| 000A <sub>H</sub>                            | TBTC                  | Timebase timer control register                             | R/W | 00000000 <sub>B</sub> |
| 000B <sub>H</sub>                            | WPCR                  | Watch prescaler control register                            | R/W | 00000000 <sub>B</sub> |
| 000C <sub>H</sub>                            | WDTC                  | Watchdog timer control register                             | R/W | 00000000 <sub>B</sub> |
| 000D <sub>H</sub>                            | SYCC2                 | System clock control register 2                             | R/W | XX100011 <sub>B</sub> |
| 000E <sub>H</sub><br>to<br>0015 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0016 <sub>H</sub>                            | PDR6                  | Port 6 data register  | R/W | 00000000 <sub>B</sub> |
| 0017 <sub>H</sub>                            | DDR6                  | Port 6 direction register                                   | R/W | 00000000 <sub>B</sub> |
| 0018 <sub>H</sub><br>to<br>0027 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0028 <sub>H</sub>                            | PDRF                  | Port F data register  | R/W | 00000000 <sub>B</sub> |
| 0029 <sub>H</sub>                            | DDRF                  | Port F direction register                                   | R/W | 00000000 <sub>B</sub> |
| 002A <sub>H</sub>                            | PDRG                  | Port G data register  | R/W | 00000000 <sub>B</sub> |
| 002B <sub>H</sub>                            | DDRG                  | Port G direction register                                   | R/W | 00000000 <sub>B</sub> |
| 002C <sub>H</sub>                            | PUL0                  | Port 0 pull-up register                                     | R/W | 00000000 <sub>B</sub> |
| 002D <sub>H</sub><br>to<br>0034 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0035 <sub>H</sub>                            | PULG                  | Port G pull-up register                                     | R/W | 00000000 <sub>B</sub> |
| 0036 <sub>H</sub>                            | T01CR1                | 8/16-bit composite timer 01 control status register 1 ch. 0 | R/W | 00000000 <sub>B</sub> |
| 0037 <sub>H</sub>                            | T00CR1                | 8/16-bit composite timer 00 control status register 1 ch. 0 | R/W | 00000000 <sub>B</sub> |
| 0038 <sub>H</sub>                            | T11CR1                | 8/16-bit composite timer 11 control status register 1 ch. 1 | R/W | 00000000 <sub>B</sub> |
| 0039 <sub>H</sub>                            | T10CR1                | 8/16-bit composite timer 10 control status register 1 ch. 1 | R/W | 00000000 <sub>B</sub> |
| 003A <sub>H</sub><br>to<br>0048 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0049 <sub>H</sub>                            | EIC10                 | External interrupt circuit control register ch. 2/ch. 3     | R/W | 00000000 <sub>B</sub> |

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| Address                                      | Register abbreviation | Register name   | R/W | Initial value         |
|--|-----------------------|---|-----|-----------------------|
| 004A <sub>H</sub>                            | EIC20                 | External interrupt circuit control register ch. 4/ch. 5           | R/W | 00000000 <sub>B</sub> |
| 004B <sub>H</sub>                            | EIC30                 | External interrupt circuit control register ch. 6/ch. 7           | R/W | 00000000 <sub>B</sub> |
| 004C <sub>H</sub><br>to<br>004F <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0050 <sub>H</sub>                            | SCR                   | LIN-UART serial control register                                  | R/W | 00000000 <sub>B</sub> |
| 0051 <sub>H</sub>                            | SMR                   | LIN-UART serial mode register                                     | R/W | 00000000 <sub>B</sub> |
| 0052 <sub>H</sub>                            | SSR                   | LIN-UART serial status register                                   | R/W | 00001000 <sub>B</sub> |
| 0053 <sub>H</sub>                            | RDR/TDR               | LIN-UART reception/transmission data register                     | R/W | 00000000 <sub>B</sub> |
| 0054 <sub>H</sub>                            | ESCR                  | LIN-UART extended status control register                         | R/W | 00000100 <sub>B</sub> |
| 0055 <sub>H</sub>                            | ECCR                  | LIN-UART extended communication control register                  | R/W | 000000XX <sub>B</sub> |
| 0056 <sub>H</sub><br>to<br>006B <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 006C <sub>H</sub>                            | ADC1                  | 8/10-bit A/D converter control register 1                         | R/W | 00000000 <sub>B</sub> |
| 006D <sub>H</sub>                            | ADC2                  | 8/10-bit A/D converter control register 2                         | R/W | 00000000 <sub>B</sub> |
| 006E <sub>H</sub>                            | ADDH                  | 8/10-bit A/D converter data register (Upper)                      | R/W | 00000000 <sub>B</sub> |
| 006F <sub>H</sub>                            | ADDL                  | 8/10-bit A/D converter data register (Lower)                      | R/W | 00000000 <sub>B</sub> |
| 0070 <sub>H</sub><br>to<br>0071 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0072 <sub>H</sub>                            | FSR                   | Flash memory status register                                      | R/W | 000X0000 <sub>B</sub> |
| 0073 <sub>H</sub><br>to<br>0075 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0076 <sub>H</sub>                            | WREN                  | Wild register address compare enable register                     | R/W | 00000000 <sub>B</sub> |
| 0077 <sub>H</sub>                            | WROR                  | Wild register data test setting register                          | R/W | 00000000 <sub>B</sub> |
| 0078 <sub>H</sub>                            | —                     | Mirror of register bank pointer (RP) and direct bank pointer (DP) | —   | —                     |
| 0079 <sub>H</sub>                            | ILR0                  | Interrupt level setting register 0                                | R/W | 11111111 <sub>B</sub> |
| 007A <sub>H</sub>                            | ILR1                  | Interrupt level setting register 1                                | R/W | 11111111 <sub>B</sub> |
| 007B <sub>H</sub>                            | ILR2                  | Interrupt level setting register 2                                | R/W | 11111111 <sub>B</sub> |
| 007C <sub>H</sub>                            | ILR3                  | Interrupt level setting register 3                                | R/W | 11111111 <sub>B</sub> |
| 007D <sub>H</sub>                            | ILR4                  | Interrupt level setting register 4                                | R/W | 11111111 <sub>B</sub> |
| 007E <sub>H</sub>                            | ILR5                  | Interrupt level setting register 5                                | R/W | 11111111 <sub>B</sub> |
| 007F <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0F80 <sub>H</sub>                            | WRARH0                | Wild register address setting register (Upper) ch. 0              | R/W | 00000000 <sub>B</sub> |
| 0F81 <sub>H</sub>                            | WRARL0                | Wild register address setting register (Lower) ch. 0              | R/W | 00000000 <sub>B</sub> |

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| Address                                      | Register abbreviation | Register name  | R/W | Initial value         |
|--|-----------------------|--|-----|-----------------------|
| 0F82 <sub>H</sub>                            | WRDR0                 | Wild register data setting register ch. 0                        | R/W | 00000000 <sub>B</sub> |
| 0F83 <sub>H</sub>                            | WRARH1                | Wild register address setting register (Upper) ch. 1             | R/W | 00000000 <sub>B</sub> |
| 0F84 <sub>H</sub>                            | WRARL1                | Wild register address setting register (Lower) ch. 1             | R/W | 00000000 <sub>B</sub> |
| 0F85 <sub>H</sub>                            | WRDR1                 | Wild register data setting register ch. 1                        | R/W | 00000000 <sub>B</sub> |
| 0F86 <sub>H</sub>                            | WRARH2                | Wild register address setting register (Upper) ch. 2             | R/W | 00000000 <sub>B</sub> |
| 0F87 <sub>H</sub>                            | WRARL2                | Wild register address setting register (Lower) ch. 2             | R/W | 00000000 <sub>B</sub> |
| 0F88 <sub>H</sub>                            | WRDR2                 | Wild register data setting register ch. 2                        | R/W | 00000000 <sub>B</sub> |
| 0F89 <sub>H</sub><br>to<br>0F91 <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0F92 <sub>H</sub>                            | T01CR0                | 8/16-bit composite timer 01 control status register 0 ch. 0      | R/W | 00000000 <sub>B</sub> |
| 0F93 <sub>H</sub>                            | T00CR0                | 8/16-bit composite timer 00 control status register 0 ch. 0      | R/W | 00000000 <sub>B</sub> |
| 0F94 <sub>H</sub>                            | T01DR                 | 8/16-bit composite timer 01 data register ch. 0                  | R/W | 00000000 <sub>B</sub> |
| 0F95 <sub>H</sub>                            | T00DR                 | 8/16-bit composite timer 00 data register ch. 0                  | R/W | 00000000 <sub>B</sub> |
| 0F96 <sub>H</sub>                            | TMCR0                 | 8/16-bit composite timer 00/01 timer mode control register ch. 0 | R/W | 00000000 <sub>B</sub> |
| 0F97 <sub>H</sub>                            | T11CR0                | 8/16-bit composite timer 11 control status register 0 ch. 1      | R/W | 00000000 <sub>B</sub> |
| 0F98 <sub>H</sub>                            | T10CR0                | 8/16-bit composite timer 10 control status register 0 ch. 1      | R/W | 00000000 <sub>B</sub> |
| 0F99 <sub>H</sub>                            | T11DR                 | 8/16-bit composite timer 11 data register ch. 1                  | R/W | 00000000 <sub>B</sub> |
| 0F9A <sub>H</sub>                            | T10DR                 | 8/16-bit composite timer 10 data register ch. 1                  | R/W | 00000000 <sub>B</sub> |
| 0F9B <sub>H</sub>                            | TMCR1                 | 8/16-bit composite timer 10/11 timer mode control register ch. 1 | R/W | 00000000 <sub>B</sub> |
| 0F9C <sub>H</sub><br>to<br>0FBB <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0FBC <sub>H</sub>                            | BGR1                  | LIN-UART baud rate generator register 1                          | R/W | 00000000 <sub>B</sub> |
| 0FBD <sub>H</sub>                            | BGR0                  | LIN-UART baud rate generator register 0                          | R/W | 00000000 <sub>B</sub> |
| 0FBE <sub>H</sub><br>to<br>0FC2 <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0FC3 <sub>H</sub>                            | AIDRL                 | A/D input disable register (Lower)                               | R/W | 00000000 <sub>B</sub> |
| 0FC4 <sub>H</sub><br>to<br>0FE3 <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0FE4 <sub>H</sub>                            | CRTH                  | Main CR clock trimming register (Upper)                          | R/W | 1XXXXXXX <sub>B</sub> |
| 0FE5 <sub>H</sub>                            | CRTL                  | Main CR clock trimming register (Lower)                          | R/W | 000XXXXX <sub>B</sub> |

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| Address                                      | Register abbreviation | Register name                     | R/W | Initial value         |
|--|-----------------------|-----------------------------------|-----|-----------------------|
| 0FE6 <sub>H</sub><br>to<br>0FE7 <sub>H</sub> | —                     | (Disabled)                        | —   | —                     |
| 0FE8 <sub>H</sub>                            | SYSC                  | System configuration register     | R/W | 11000011 <sub>B</sub> |
| 0FE9 <sub>H</sub>                            | CMCR                  | Clock monitoring control register | R/W | XX000000 <sub>B</sub> |
| 0FEA <sub>H</sub>                            | CMDR                  | Clock monitoring data register    | R/W | 00000000 <sub>B</sub> |
| 0FEB <sub>H</sub>                            | WDTH                  | Watchdog ID register (Upper)      | R/W | XXXXXXXX <sub>B</sub> |
| 0FEC <sub>H</sub>                            | WDTL                  | Watchdog ID register (Lower)      | R/W | XXXXXXXX <sub>B</sub> |
| 0FED <sub>H</sub>                            | —                     | (Disabled)                        | —   | —                     |
| 0FEE <sub>H</sub>                            | ILSR                  | Input level select register       | R/W | 00000000 <sub>B</sub> |
| 0FEF <sub>H</sub><br>to<br>0FFF <sub>H</sub> | —                     | (Disabled)                        | —   | —                     |

- R/W access symbols

R/W : Readable / Writable

R : Read only

W : Write only

- Initial value symbols

0 : The initial value of this bit is "0".

1 : The initial value of this bit is "1".

X : The initial value of this bit is undefined.

Note: Do not write to an address that is "(Disabled)". If a "(Disabled)" address is read, an undefined value is returned.

## ■ I/O MAP (MB95210H Series)

| Address                                      | Register abbreviation | Register name   | R/W | Initial value         |
|--|-----------------------|---|-----|-----------------------|
| 0000 <sub>H</sub>                            | PDR0                  | Port 0 data register  | R/W | 00000000 <sub>B</sub> |
| 0001 <sub>H</sub>                            | DDR0                  | Port 0 direction register                                   | R/W | 00000000 <sub>B</sub> |
| 0002 <sub>H</sub>                            | PDR1                  | Port 1 data register  | R/W | 00000000 <sub>B</sub> |
| 0003 <sub>H</sub>                            | DDR1                  | Port 1 direction register                                   | R/W | 00000000 <sub>B</sub> |
| 0004 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0005 <sub>H</sub>                            | WATR                  | Oscillation stabilization wait time setting register        | R/W | 11111111 <sub>B</sub> |
| 0006 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0007 <sub>H</sub>                            | SYCC                  | System clock control register                               | R/W | XXXXXX11 <sub>B</sub> |
| 0008 <sub>H</sub>                            | STBC                  | Standby control register                                    | R/W | 00000XXX <sub>B</sub> |
| 0009 <sub>H</sub>                            | RSRR                  | Reset source register                                       | R   | XXXXXXXX <sub>B</sub> |
| 000A <sub>H</sub>                            | TBTC                  | Timebase timer control register                             | R/W | 00000000 <sub>B</sub> |
| 000B <sub>H</sub>                            | WPCR                  | Watch prescaler control register                            | R/W | 00000000 <sub>B</sub> |
| 000C <sub>H</sub>                            | WDTC                  | Watchdog timer control register                             | R/W | 00000000 <sub>B</sub> |
| 000D <sub>H</sub>                            | SYCC2                 | System clock control register 2                             | R/W | XX100011 <sub>B</sub> |
| 000E <sub>H</sub><br>to<br>0015 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0016 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0017 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0018 <sub>H</sub><br>to<br>0027 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0028 <sub>H</sub>                            | PDRF                  | Port F data register  | R/W | 00000000 <sub>B</sub> |
| 0029 <sub>H</sub>                            | DDRF                  | Port F direction register                                   | R/W | 00000000 <sub>B</sub> |
| 002A <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 002B <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 002C <sub>H</sub>                            | PUL0                  | Port 0 pull-up register                                     | R/W | 00000000 <sub>B</sub> |
| 002D <sub>H</sub><br>to<br>0034 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0035 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0036 <sub>H</sub>                            | T01CR1                | 8/16-bit composite timer 01 control status register 1 ch. 0 | R/W | 00000000 <sub>B</sub> |
| 0037 <sub>H</sub>                            | T00CR1                | 8/16-bit composite timer 00 control status register 1 ch. 0 | R/W | 00000000 <sub>B</sub> |
| 0038 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0039 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 003A <sub>H</sub><br>to<br>0048 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0049 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |

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| Address                                      | Register abbreviation | Register name   | R/W | Initial value         |
|--|-----------------------|---|-----|-----------------------|
| 004A <sub>H</sub>                            | EIC20                 | External interrupt circuit control register ch. 4                 | R/W | 00000000 <sub>B</sub> |
| 004B <sub>H</sub>                            | EIC30                 | External interrupt circuit control register ch. 6                 | R/W | 00000000 <sub>B</sub> |
| 004C <sub>H</sub><br>to<br>004F <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0050 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0051 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0052 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0053 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0054 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0055 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0056 <sub>H</sub><br>to<br>006B <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 006C <sub>H</sub>                            | ADC1                  | 8/10-bit A/D converter control register 1                         | R/W | 00000000 <sub>B</sub> |
| 006D <sub>H</sub>                            | ADC2                  | 8/10-bit A/D converter control register 2                         | R/W | 00000000 <sub>B</sub> |
| 006E <sub>H</sub>                            | ADDH                  | 8/10-bit A/D converter data register (Upper)                      | R/W | 00000000 <sub>B</sub> |
| 006F <sub>H</sub>                            | ADDL                  | 8/10-bit A/D converter data register (Lower)                      | R/W | 00000000 <sub>B</sub> |
| 0070 <sub>H</sub><br>to<br>0071 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0072 <sub>H</sub>                            | FSR                   | Flash memory status register                                      | R/W | 000X0000 <sub>B</sub> |
| 0073 <sub>H</sub><br>to<br>0075 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0076 <sub>H</sub>                            | WREN                  | Wild register address compare enable register                     | R/W | 00000000 <sub>B</sub> |
| 0077 <sub>H</sub>                            | WROR                  | Wild register data test setting register                          | R/W | 00000000 <sub>B</sub> |
| 0078 <sub>H</sub>                            | —                     | Mirror of register bank pointer (RP) and direct bank pointer (DP) | —   | —                     |
| 0079 <sub>H</sub>                            | ILR0                  | Interrupt level setting register 0                                | R/W | 11111111 <sub>B</sub> |
| 007A <sub>H</sub>                            | ILR1                  | Interrupt level setting register 1                                | R/W | 11111111 <sub>B</sub> |
| 007B <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 007C <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 007D <sub>H</sub>                            | ILR4                  | Interrupt level setting register 4                                | R/W | 11111111 <sub>B</sub> |
| 007E <sub>H</sub>                            | ILR5                  | Interrupt level setting register 5                                | R/W | 11111111 <sub>B</sub> |
| 007F <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0F80 <sub>H</sub>                            | WRARH0                | Wild register address setting register (Upper) ch. 0              | R/W | 00000000 <sub>B</sub> |
| 0F81 <sub>H</sub>                            | WRARL0                | Wild register address setting register (Lower) ch. 0              | R/W | 00000000 <sub>B</sub> |
| 0F82 <sub>H</sub>                            | WRDR0                 | Wild register data setting register ch. 0                         | R/W | 00000000 <sub>B</sub> |

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| Address                                      | Register abbreviation | Register name  | R/W | Initial value         |
|--|-----------------------|--|-----|-----------------------|
| 0F83 <sub>H</sub>                            | WRARH1                | Wild register address setting register (Upper) ch. 1             | R/W | 00000000 <sub>B</sub> |
| 0F84 <sub>H</sub>                            | WRARL1                | Wild register address setting register (Lower) ch. 1             | R/W | 00000000 <sub>B</sub> |
| 0F85 <sub>H</sub>                            | WRDR1                 | Wild register data setting register ch. 1                        | R/W | 00000000 <sub>B</sub> |
| 0F86 <sub>H</sub>                            | WRARH2                | Wild register address setting register (Upper) ch. 2             | R/W | 00000000 <sub>B</sub> |
| 0F87 <sub>H</sub>                            | WRARL2                | Wild register address setting register (Lower) ch. 2             | R/W | 00000000 <sub>B</sub> |
| 0F88 <sub>H</sub>                            | WRDR2                 | Wild register data setting register ch. 2                        | R/W | 00000000 <sub>B</sub> |
| 0F89 <sub>H</sub><br>to<br>0F91 <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0F92 <sub>H</sub>                            | T01CR0                | 8/16-bit composite timer 01 control status register 0 ch. 0      | R/W | 00000000 <sub>B</sub> |
| 0F93 <sub>H</sub>                            | T00CR0                | 8/16-bit composite timer 00 control status register 0 ch. 0      | R/W | 00000000 <sub>B</sub> |
| 0F94 <sub>H</sub>                            | T01DR                 | 8/16-bit composite timer 01 data register ch. 0                  | R/W | 00000000 <sub>B</sub> |
| 0F95 <sub>H</sub>                            | T00DR                 | 8/16-bit composite timer 00 data register ch. 0                  | R/W | 00000000 <sub>B</sub> |
| 0F96 <sub>H</sub>                            | TMCR0                 | 8/16-bit composite timer 00/01 timer mode control register ch. 0 | R/W | 00000000 <sub>B</sub> |
| 0F97 <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0F98 <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0F99 <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0F9A <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0F9B <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0F9C <sub>H</sub><br>to<br>0FBB <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0FBC <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0FBD <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0FBE <sub>H</sub><br>to<br>0FC2 <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0FC3 <sub>H</sub>                            | AIDRL                 | A/D input disable register (Lower)                               | R/W | 00000000 <sub>B</sub> |
| 0FC4 <sub>H</sub><br>to<br>0FE3 <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0FE4 <sub>H</sub>                            | CRTH                  | Main CR clock trimming register (Upper)                          | R/W | 1XXXXXXX <sub>B</sub> |
| 0FE5 <sub>H</sub>                            | CRTL                  | Main CR clock trimming register (Lower)                          | R/W | 000XXXXX <sub>B</sub> |
| 0FE6 <sub>H</sub><br>to<br>0FE7 <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0FE8 <sub>H</sub>                            | SYSC                  | System configuration register                                    | R/W | 11000011 <sub>B</sub> |

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| Address                                      | Register abbreviation | Register name                                | R/W | Initial value         |
|--|-----------------------|--|-----|-----------------------|
| 0FE9 <sub>H</sub>                            | CMCR                  | Clock monitoring control register            | R/W | XX000000 <sub>B</sub> |
| 0FEA <sub>H</sub>                            | CMDR                  | Clock monitoring data register               | R/W | 00000000 <sub>B</sub> |
| 0FEB <sub>H</sub>                            | WDTH                  | Watchdog timer selection ID register (Upper) | R/W | XXXXXXXX <sub>B</sub> |
| 0FEC <sub>H</sub>                            | WDTL                  | Watchdog timer selection ID register (Lower) | R/W | XXXXXXXX <sub>B</sub> |
| 0FED <sub>H</sub>                            | —                     | (Disabled)                                   | —   | —                     |
| 0FEE <sub>H</sub>                            | ILSR                  | Input level select register                  | R/W | 00000000 <sub>B</sub> |
| 0FEF <sub>H</sub><br>to<br>0FFF <sub>H</sub> | —                     | (Disabled)                                   | —   | —                     |

- R/W access symbols

R/W : Readable / Writable

R : Read only

W : Write only

- Initial value symbols


0 : The initial value of this bit is "0".

1 : The initial value of this bit is "1".

X : The initial value of this bit is undefined.

Note: Do not write to an address that is "(Disabled)". If a "(Disabled)" address is read, an undefined value is returned.

**■ INTERRUPT SOURCE TABLE (MB95200H Series)**

| Interrupt source                       | Interrupt request number | Vector table address |                   | Bit name of interrupt level setting register | Priority order of interrupt sources of the same level (occurring simultaneously)                    |
|--|--------------------------|----------------------|-------------------|--|---|
|  |                          | Upper                | Lower             |  |   |
| External interrupt ch. 4               | IRQ0                     | FFFA <sub>H</sub>    | FFFB <sub>H</sub> | L00 [1 : 0]                                  | High<br><br>Low |
| External interrupt ch. 5               | IRQ1                     | FFF8 <sub>H</sub>    | FFF9 <sub>H</sub> | L01 [1 : 0]                                  |   |
| External interrupt ch. 2               | IRQ2                     | FFF6 <sub>H</sub>    | FFF7 <sub>H</sub> | L02 [1 : 0]                                  |   |
| External interrupt ch. 6               |                          |                      |                   |  |   |
| External interrupt ch. 3               | IRQ3                     | FFF4 <sub>H</sub>    | FFF5 <sub>H</sub> | L03 [1 : 0]                                  |   |
| External interrupt ch. 7               |                          |                      |                   |  |   |
| —                                      | IRQ4                     | FFF2 <sub>H</sub>    | FFF3 <sub>H</sub> | L04 [1 : 0]                                  |   |
| 8/16-bit composite timer ch. 0 (Lower) | IRQ5                     | FFF0 <sub>H</sub>    | FFF1 <sub>H</sub> | L05 [1 : 0]                                  |   |
| 8/16-bit composite timer ch. 0 (Upper) | IRQ6                     | FFEE <sub>H</sub>    | FFEF <sub>H</sub> | L06 [1 : 0]                                  |   |
| LIN-UART (reception)                   | IRQ7                     | FFEC <sub>H</sub>    | FFED <sub>H</sub> | L07 [1 : 0]                                  |   |
| LIN-UART (transmission)                | IRQ8                     | FFEA <sub>H</sub>    | FFEB <sub>H</sub> | L08 [1 : 0]                                  |   |
| —                                      | IRQ9                     | FFE8 <sub>H</sub>    | FFE9 <sub>H</sub> | L09 [1 : 0]                                  |   |
| —                                      | IRQ10                    | FFE6 <sub>H</sub>    | FFE7 <sub>H</sub> | L10 [1 : 0]                                  |   |
| —                                      | IRQ11                    | FFE4 <sub>H</sub>    | FFE5 <sub>H</sub> | L11 [1 : 0]                                  |   |
| —                                      | IRQ12                    | FFE2 <sub>H</sub>    | FFE3 <sub>H</sub> | L12 [1 : 0]                                  |   |
| —                                      | IRQ13                    | FFE0 <sub>H</sub>    | FFE1 <sub>H</sub> | L13 [1 : 0]                                  |   |
| 8/16-bit composite timer ch. 1 (Upper) | IRQ14                    | FFDE <sub>H</sub>    | FFDF <sub>H</sub> | L14 [1 : 0]                                  |   |
| —                                      | IRQ15                    | FFDC <sub>H</sub>    | FFDD <sub>H</sub> | L15 [1 : 0]                                  |   |
| —                                      | IRQ16                    | FFDA <sub>H</sub>    | FFDB <sub>H</sub> | L16 [1 : 0]                                  |   |
| —                                      | IRQ17                    | FFD8 <sub>H</sub>    | FFD9 <sub>H</sub> | L17 [1 : 0]                                  |   |
| 8/10-bit A/D converter                 | IRQ18                    | FFD6 <sub>H</sub>    | FFD7 <sub>H</sub> | L18 [1 : 0]                                  |   |
| Timebase timer                         | IRQ19                    | FFD4 <sub>H</sub>    | FFD5 <sub>H</sub> | L19 [1 : 0]                                  |   |
| Watch prescaler                        | IRQ20                    | FFD2 <sub>H</sub>    | FFD3 <sub>H</sub> | L20 [1 : 0]                                  |   |
| —                                      | IRQ21                    | FFD0 <sub>H</sub>    | FFD1 <sub>H</sub> | L21 [1 : 0]                                  |   |
| 8/16-bit composite timer ch. 1 (Lower) | IRQ22                    | FFCE <sub>H</sub>    | FFCF <sub>H</sub> | L22 [1 : 0]                                  |   |
| Flash memory                           | IRQ23                    | FFCC <sub>H</sub>    | FFCD <sub>H</sub> | L23 [1 : 0]                                  |   |

## ■ INTERRUPT SOURCE TABLE (MB95210H Series)

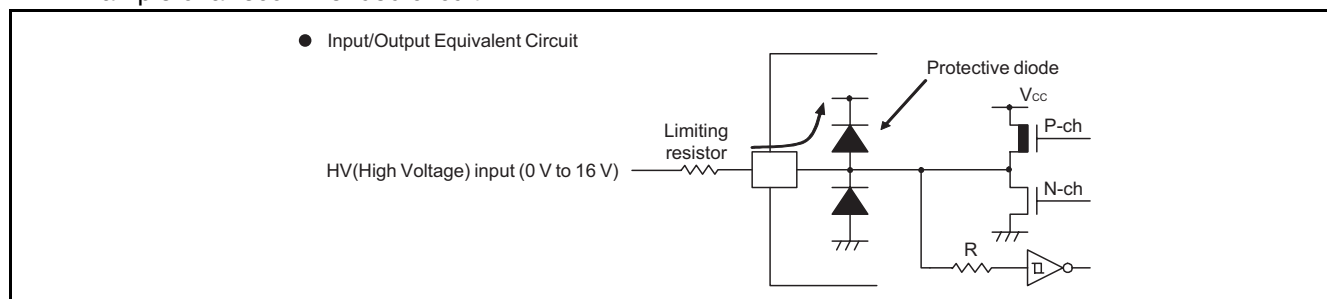
| Interrupt source                       | Interrupt request number | Vector table address |                   | Bit name of interrupt level setting register | Priority of interrupts of the same level (at simultaneous occurrence)  |
|--|--------------------------|----------------------|-------------------|--|--|
|  |                          | Upper                | Lower             |  |  |
| External interrupt ch. 4               | IRQ0                     | FFFA <sub>H</sub>    | FFFB <sub>H</sub> | L00 [1 : 0]                                  | <div style="text-align: center;">High</div> <div style="text-align: center;">↑</div> <div style="text-align: center;">↓</div> <div style="text-align: center;">Low</div> |
| —                                      | IRQ1                     | FFF8 <sub>H</sub>    | FFF9 <sub>H</sub> | L01 [1 : 0]                                  |  |
| —                                      | IRQ2                     | FFF6 <sub>H</sub>    | FFF7 <sub>H</sub> | L02 [1 : 0]                                  |  |
| External interrupt ch. 6               |                          |                      |                   |  |  |
| —                                      | IRQ3                     | FFF4 <sub>H</sub>    | FFF5 <sub>H</sub> | L03 [1 : 0]                                  |  |
| —                                      |                          |                      |                   |  |  |
| —                                      | IRQ4                     | FFF2 <sub>H</sub>    | FFF3 <sub>H</sub> | L04 [1 : 0]                                  |  |
| 8/16-bit composite timer ch. 0 (Lower) | IRQ5                     | FFF0 <sub>H</sub>    | FFF1 <sub>H</sub> | L05 [1 : 0]                                  |  |
| 8/16-bit composite timer ch. 0 (Upper) | IRQ6                     | FFEE <sub>H</sub>    | FFEF <sub>H</sub> | L06 [1 : 0]                                  |  |
| —                                      | IRQ7                     | FFEC <sub>H</sub>    | FFED <sub>H</sub> | L07 [1 : 0]                                  |  |
| —                                      | IRQ8                     | FFEA <sub>H</sub>    | FFEB <sub>H</sub> | L08 [1 : 0]                                  |  |
| —                                      | IRQ9                     | FFE8 <sub>H</sub>    | FFE9 <sub>H</sub> | L09 [1 : 0]                                  |  |
| —                                      | IRQ10                    | FFE6 <sub>H</sub>    | FFE7 <sub>H</sub> | L10 [1 : 0]                                  |  |
| —                                      | IRQ11                    | FFE4 <sub>H</sub>    | FFE5 <sub>H</sub> | L11 [1 : 0]                                  |  |
| —                                      | IRQ12                    | FFE2 <sub>H</sub>    | FFE3 <sub>H</sub> | L12 [1 : 0]                                  |  |
| —                                      | IRQ13                    | FFE0 <sub>H</sub>    | FFE1 <sub>H</sub> | L13 [1 : 0]                                  |  |
| —                                      | IRQ14                    | FFDE <sub>H</sub>    | FFDF <sub>H</sub> | L14 [1 : 0]                                  |  |
| —                                      | IRQ15                    | FFDC <sub>H</sub>    | FFDD <sub>H</sub> | L15 [1 : 0]                                  |  |
| —                                      | IRQ16                    | FFDA <sub>H</sub>    | FFDB <sub>H</sub> | L16 [1 : 0]                                  |  |
| —                                      | IRQ17                    | FFD8 <sub>H</sub>    | FFD9 <sub>H</sub> | L17 [1 : 0]                                  |  |
| 8/10-bit A/D converter                 | IRQ18                    | FFD6 <sub>H</sub>    | FFD7 <sub>H</sub> | L18 [1 : 0]                                  |  |
| Timebase timer                         | IRQ19                    | FFD4 <sub>H</sub>    | FFD5 <sub>H</sub> | L19 [1 : 0]                                  |  |
| Watch prescaler                        | IRQ20                    | FFD2 <sub>H</sub>    | FFD3 <sub>H</sub> | L20 [1 : 0]                                  |  |
| —                                      | IRQ21                    | FFD0 <sub>H</sub>    | FFD1 <sub>H</sub> | L21 [1 : 0]                                  |  |
| —                                      | IRQ22                    | FFCE <sub>H</sub>    | FFCF <sub>H</sub> | L22 [1 : 0]                                  |  |
| Flash memory                           | IRQ23                    | FFCC <sub>H</sub>    | FFCD <sub>H</sub> | L23 [1 : 0]                                  |  |

## ■ ELECTRICAL CHARACTERISTICS

### 1. Absolute Maximum Ratings

| Parameter                              | Symbol              | Rating         |              | Unit | Remarks  |
|--|---------------------|----------------|--------------|------|--|
|  |                     | Min            | Max          |      |  |
| Power supply voltage*1                 | $V_{CC}$            | $V_{SS} - 0.3$ | $V_{SS} + 6$ | V    |  |
| Input voltage*1                        | $V_I$               | $V_{SS} - 0.3$ | $V_{SS} + 6$ | V    | *2   |
| Output voltage*1                       | $V_O$               | $V_{SS} - 0.3$ | $V_{SS} + 6$ | V    | *2   |
| Maximum clamp current                  | $I_{CLAMP}$         | - 2            | + 2          | mA   | Applicable to pins*3   |
| Total maximum clamp current            | $\Sigma I_{CLAMP} $ | —              | 20           | mA   | Applicable to pins*3   |
| “L” level maximum output current       | $I_{OL1}$           | —              | 15           | mA   | Other than P05, P06, P62 and P63*5   |
|  | $I_{OL2}$           |                | 15           |      | P05, P06, P62 and P63*5  |
| “L” level average current              | $I_{OLAV1}$         | —              | 4            | mA   | Other than P05, P06, P62 and P63*5<br>Average output current =<br>operating current × operating ratio<br>(1 pin) |
|  | $I_{OLAV2}$         |                | 12           |      | P05, P06, P62 and P63*5<br>Average output current =<br>operating current × operating ratio<br>(1 pin)            |
| “L” level total maximum output current | $\Sigma I_{OL}$     | —              | 100          | mA   |  |
| “L” level total average output current | $\Sigma I_{OLAV}$   | —              | 50           | mA   | Total average output current =<br>operating current × operating ratio<br>(Total number of pins)                  |
| “H” level maximum output current       | $I_{OH1}$           | —              | - 15         | mA   | Other than P05, P06, P62 and P63*5   |
|  | $I_{OH2}$           |                | - 15         |      | P05, P06, P62 and P63*5  |
| “H” level average current              | $I_{OHAV1}$         | —              | - 4          | mA   | Other than P05, P06, P62 and P63*5<br>Average output current =<br>operating current × operating ratio<br>(1 pin) |
|  | $I_{OHAV2}$         |                | - 8          |      | P05, P06, P62 and P63*5<br>Average output current =<br>operating current × operating ratio<br>(1 pin)            |
| “H” level total maximum output current | $\Sigma I_{OH}$     | —              | - 100        | mA   |  |
| “H” level total average output current | $\Sigma I_{OHAV}$   | —              | - 50         | mA   | Total average output current =<br>operating current × operating ratio<br>(Total number of pins)                  |
| Power consumption                      | $P_d$               | —              | 320          | mW   |  |
| Operating temperature                  | $T_A$               | - 40           | + 85         | °C   |  |
| Storage temperature                    | $T_{stg}$           | - 55           | + 150        | °C   |  |

- \*1: The parameter is based on  $V_{SS} = 0.0 \text{ V}$ .
- \*2:  $V_i$  and  $V_o$  must not exceed  $V_{CC} + 0.3 \text{ V}$ .  $V_i$  must not exceed the rated voltage. However, if the maximum current to/from an input is limited by means of an external component, the  $I_{CLAMP}$  rating is used instead of the  $V_i$  rating.
- \*3: Applicable to pins: P00 to P07, P62 to P64, PG1 to PG2, PF0, PF1\*4
  - Use under recommended operating conditions.
  - Use with DC voltage (current).
  - The HV (High Voltage) signal is an input signal exceeding the  $V_{CC}$  voltage. Always connect a limiting resistor between the HV (High Voltage) signal and the microcontroller before applying the HV (High Voltage) signal.
  - The value of the limiting resistor should be set to a value at which the current to be input to the microcontroller pin when the HV (High Voltage) signal is input is below the standard value, irrespective of whether the current is transient current or stationary current.
  - When the microcontroller drive current is low, such as in low power consumption modes, the HV (High Voltage) input potential may pass through the protective diode to increase the potential of the  $V_{CC}$  pin, affecting other devices.
  - If the HV (High Voltage) signal is input when the microcontroller power supply is off (not fixed at 0 V), since power is supplied from the pins, incomplete operations may be executed.
  - If the HV (High Voltage) input is input after power-on, since power is supplied from the pins, the voltage of power supply may not be sufficient to enable a power-on reset.
  - Do not leave the HV (High Voltage) input pin unconnected.
  - Example of a recommended circuit :



\*4: P00 to P03, P07, P62 to P64, PG1 to PG2, PF0 and PF1 are available in MB95F204H/F203H/F202H/F204K/F203K/F202K.

\*5: P62 and P63 are available in MB95F204H/F203H/F202H/F204K/F203K/F202K.

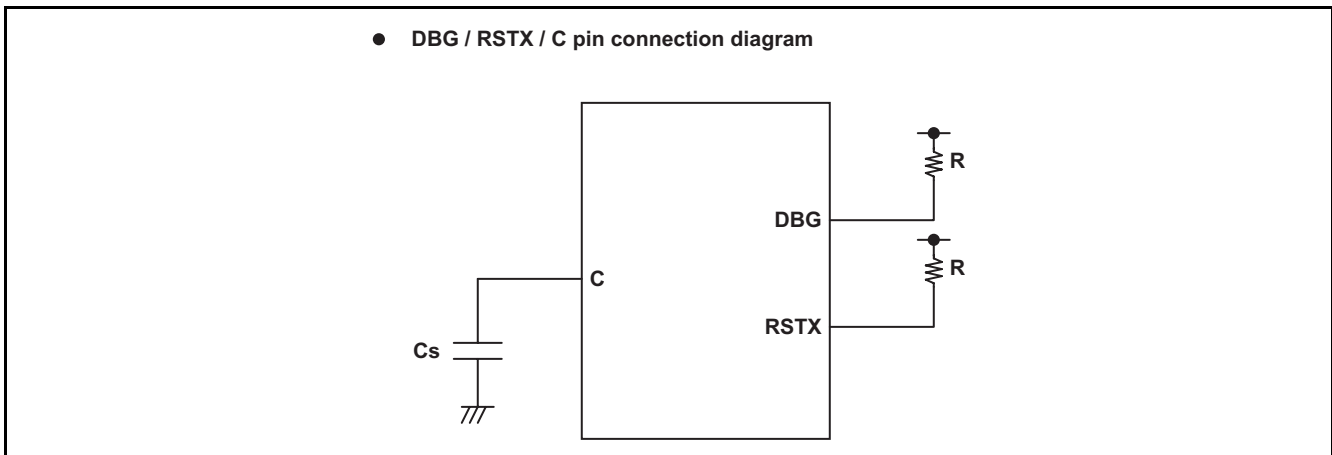
**WARNING:** A semiconductor device may be damaged by applying stress (voltage, current, temperature, etc.) in excess of the absolute maximum rating. Therefore, ensure that not a single parameter exceeds its absolute maximum rating.

2. Recommended Operating Conditions

(V<sub>SS</sub> = 0.0 V)

| Parameter             | Symbol          | Value               |                   | Unit | Remarks                            |                               |
|-----------------------|-----------------|---------------------|-------------------|------|------------------------------------|-------------------------------|
|                       |                 | Min                 | Max               |      |                                    |                               |
| Power supply voltage  | V <sub>CC</sub> | 2.4 <sup>*1*2</sup> | 5.5 <sup>*1</sup> | V    | In normal operation                | Other than on-chip debug mode |
|                       |                 | 2.3                 | 5.5               |      | Hold condition in stop mode        |                               |
|                       |                 | 2.7                 | 5.5               |      | In normal operation                | On-chip debug mode            |
|                       |                 | 2.3                 | 5.5               |      | Hold condition in stop mode        |                               |
| Smoothing capacitor   | C <sub>S</sub>  | 0.022               | 1                 | μF   | *3                                 |                               |
| Operating temperature | T <sub>A</sub>  | - 40                | + 85              | °C   | Without the on-chip debug function |                               |
|                       |                 | + 5                 | + 35              |      | With the on-chip debug function    |                               |

- \*1: The value varies depending on the operating frequency, the machine clock and the analog guaranteed range.
- \*2: The value is 2.88 V when the low-voltage detection reset is used.
- \*3: Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The bypass capacitor for the V<sub>CC</sub> pin must have a capacitance larger than C<sub>S</sub>. For the connection to a smoothing capacitor C<sub>S</sub>, see the diagram below. To prevent the device from unintentionally entering an unknown mode due to noise, minimize the distance between the C pin and C<sub>S</sub> and the distance between C<sub>S</sub> and the V<sub>SS</sub> pin when designing the layout of a printed circuit board.



**WARNING:** The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the electrical characteristics of the device are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact sales representatives beforehand.

### 3. DC Characteristics

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

| Parameter                                     | Symbol     | Pin name  | Condition                     | Value          |     |                | Unit          | Remarks  |
|---|------------|---|-------------------------------|----------------|-----|----------------|---------------|--|
|   |            |   |                               | Min            | Typ | Max            |               |  |
| "H" level input voltage                       | $V_{IHI}$  | P04   | *1                            | $0.7 V_{CC}$   | —   | $V_{CC} + 0.3$ | V             | When CMOS input level (hysteresis input) is selected |
|   | $V_{IHS}$  | P00 to P07, P12, P62 to P64, PF0 to PF1, PG1 to PG2                 | *1                            | $0.8 V_{CC}$   | —   | $V_{CC} + 0.3$ | V             | Hysteresis input                                     |
|   | $V_{IHM}$  | PF2   | —                             | $0.7 V_{CC}$   | —   | $V_{CC} + 0.3$ | V             | Hysteresis input                                     |
| "L" level input voltage                       | $V_{IL}$   | P04   | *1                            | $V_{SS} - 0.3$ | —   | $0.3 V_{CC}$   | V             | When CMOS input level (hysteresis input) is selected |
|   | $V_{ILS}$  | P00 to P07, P12, P62 to P64, PF0 to PF1, PG1 to PG2                 | *1                            | $V_{SS} - 0.3$ | —   | $0.2 V_{CC}$   | V             | Hysteresis input                                     |
|   | $V_{ILM}$  | PF2   | —                             | $V_{SS} - 0.3$ | —   | $0.3 V_{CC}$   | V             | Hysteresis input                                     |
| Open-drain output application voltage         | $V_D$      | PF2, P12  | —                             | $V_{SS} - 0.3$ | —   | $0.2 V_{CC}$   | V             |  |
| "H" level output voltage                      | $V_{OH1}$  | Output pins other than P05, P06, P62, P63, PF2 and P12 <sup>2</sup> | $I_{OH} = -4\text{ mA}$       | $V_{CC} - 0.5$ | —   | —              | V             |  |
|   | $V_{OH2}$  | P05, P06, P62, P63 <sup>2</sup>                                     | $I_{OH} = -8\text{ mA}$       | $V_{CC} - 0.5$ | —   | —              | V             |  |
| "L" level output voltage                      | $V_{OL1}$  | Output pins other than P05, P06, P62 and P63 <sup>2</sup>           | $I_{OL} = 4\text{ mA}$        | —              | —   | 0.4            | V             |  |
|   | $V_{OL2}$  | P05, P06, P62, P63 <sup>2</sup>                                     | $I_{OL} = 12\text{ mA}$       | —              | —   | 0.4            | V             |  |
| Input leak current (Hi-Z output leak current) | $I_{LI}$   | All input pins  | $0.0\text{ V} < V_I < V_{CC}$ | -5             | —   | +5             | $\mu\text{A}$ | When pull-up resistance is disabled                  |
| Pull-up resistance                            | $R_{PULL}$ | P00 to P07, PG1, PG2 <sup>3</sup>                                   | $V_I = 0\text{ V}$            | 25             | 50  | 100            | k $\Omega$    | When pull-up resistance is enabled                   |
| Input capacitance                             | $C_{IN}$   | Other than $V_{CC}$ and $V_{SS}$                                    | $f = 1\text{ MHz}$            | —              | 5   | 15             | pF            |  |

(Continued)



- \*1: The input level of P04 can be switched between “CMOS input level” and “hysteresis input level”. The input level selection register (ILSR) is used to switch between the two input levels.
- \*2: P62 and P63 are available in MB95F204H/F203H/F202H/F204K/F203K/F202K.
- \*3: P00 to P03, P07, PG1 and PG2 are available in MB95F204H/F203H/F202H/F204K/F203K/F202K.

(Continued)

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

| Parameter              | Symbol            | Pin name                                      | Condition  | Value |      |      | Unit | Remarks   |
|------------------------|-------------------|---|--|-------|------|------|------|---|
|                        |                   |   |  | Min   | Typ  | Max  |      |   |
| Power supply current*4 | I <sub>CC</sub>   | V <sub>CC</sub><br>(External clock operation) | V <sub>CC</sub> = 5.5 V<br>F <sub>CH</sub> = 32 MHz<br>F <sub>MP</sub> = 16 MHz<br>Main clock mode<br>(divided by 2)                           | —     | 13   | 17   | mA   | Flash memory product (except writing and erasing) |
|                        |                   |   |  | —     | 33.5 | 39.5 | mA   | Flash memory product (at writing and erasing)     |
|                        |                   |   |  | —     | 15   | 21   | mA   | At A/D conversion                                 |
|                        | I <sub>CCS</sub>  |   | V <sub>CC</sub> = 5.5 V<br>F <sub>CH</sub> = 32 MHz<br>F <sub>MP</sub> = 16 MHz<br>Main sleep mode<br>(divided by 2)                           | —     | 5.5  | 9    | mA   |   |
|                        | I <sub>CCCL</sub> |   | V <sub>CC</sub> = 5.5 V<br>F <sub>CL</sub> = 32 kHz<br>F <sub>MPL</sub> = 16 kHz<br>Subclock mode<br>(divided by 2)<br>T <sub>A</sub> = +25 °C | —     | 65   | 153  | μA   |   |
|                        | I <sub>CCLS</sub> |   | V <sub>CC</sub> = 5.5 V<br>F <sub>CL</sub> = 32 kHz<br>F <sub>MPL</sub> = 16 kHz<br>Subsleep mode<br>(divided by 2)<br>T <sub>A</sub> = +25 °C | —     | 10   | 84   | μA   |   |
|                        |                   |   |  |       |      |      |      |   |

(Continued)

(Continued)

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, V_{SS} = 0.0 \text{ V}, T_A = -40 \text{ }^\circ\text{C to } +85 \text{ }^\circ\text{C})$ 

| Parameter              | Symbol              | Pin name                                      | Condition  | Value |     |      | Unit | Remarks                                   |
|------------------------|---------------------|---|--|-------|-----|------|------|---|
|                        |                     |   |  | Min   | Typ | Max  |      |   |
| Power supply current*4 | I <sub>CC</sub> T   | V <sub>CC</sub><br>(External clock operation) | V <sub>CC</sub> = 5.5 V<br>F <sub>CL</sub> = 32 kHz<br>Watch mode<br>Main stop mode<br>T <sub>A</sub> = +25 °C                                     | —     | 5   | 30   | μA   |   |
|                        | I <sub>CC</sub> MCR |   | V <sub>CC</sub> = 5.5 V<br>F <sub>CRH</sub> = 12.5 MHz<br>F <sub>MP</sub> = 12.5 MHz<br>Main CR clock mode   | —     | 10  | 13.2 | mA   |   |
|                        | I <sub>CC</sub> SCR |   | V <sub>CC</sub> = 5.5 V<br>F <sub>CL</sub> = 32 kHz<br>F <sub>MPL</sub> = 16 kHz<br>Sub-CR clock mode<br>(divided by 2)<br>T <sub>A</sub> = +25 °C | —     | 110 | 410  | μA   |   |
|                        | I <sub>CC</sub> TS  |   | V <sub>CC</sub> = 5.5 V<br>F <sub>CH</sub> = 32 MHz<br>Timebase timer mode<br>T <sub>A</sub> = +25 °C  | —     | 1.1 | 3    | mA   |   |
|                        | I <sub>CC</sub> H   |   | V <sub>CC</sub> = 5.5 V<br>Substop mode<br>T <sub>A</sub> = +25 °C   | —     | 3.5 | 22.5 | μA   | Main stop mode for single clock selection |
|                        | I <sub>L</sub> VD   | V <sub>CC</sub>                               | Current consumption for low-voltage detection circuit only   | —     | 37  | 54   | μA   |   |
|                        | I <sub>CR</sub> H   |   | Current consumption for the internal main CR oscillator oscillating at 12.5 MHz  | —     | 0.5 | 0.6  | mA   |   |
|                        | I <sub>CR</sub> L   |   | Current consumption for the internal sub-CR oscillator oscillating at 100 kHz  | —     | 20  | 72   | μA   |   |

\*4: • The power supply current is determined by the external clock. When the low-voltage detection option is selected, the power-supply current will be the sum of adding the current consumption of the low-voltage detection circuit (I<sub>L</sub>VD) to a specified value. In addition, when both the low-voltage detection option and the internal CR oscillator are selected, the power supply current will be the sum of adding up the current con-

sumption of the low-voltage detection circuit, the current consumption of the internal CR oscillators ( $I_{CRH}$ ,  $I_{CRL}$ ) and a specified value. In on-chip debug mode, the internal CR oscillator ( $I_{CRH}$ ) and the low-voltage detection circuit are always enabled, and current consumption therefore increases accordingly.

- See "4. AC Characteristics: (1) Clock Timing" for  $F_{CH}$  and  $F_{CL}$ .
- See "4. AC Characteristics: (2) Source Clock/Machine Clock" for  $F_{MP}$  and  $F_{MPL}$ .

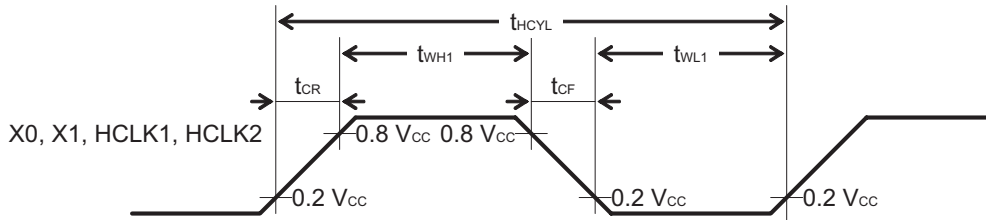
4. AC Characteristics

(1) Clock Timing

(V<sub>CC</sub> = 2.4 V to 5.5 V, V<sub>SS</sub> = 0.0 V, T<sub>A</sub> = - 40 °C to + 85 °C)

| Parameter               | Symbol                               | Pin name             | Condition | Value |       |        | Unit  | Remarks   |   |
|-------------------------|--------------------------------------|----------------------|-----------|-------|-------|--------|-------|---|---|
|                         |                                      |                      |           | Min   | Typ   | Max    |       |   |   |
| Clock frequency         | F <sub>CH</sub>                      | X0, X1               | —         | 1     | —     | 16.25  | MHz   | When the main oscillation circuit is used   |   |
|                         |                                      | X0, HCLK1, HCLK2     | X1 open   | 1     | —     | 12     | MHz   | When the main external clock is used  |   |
|                         |                                      | X0, X1, HCLK1, HCLK2 | —         | 1     | —     | 32.5   | MHz   |   |   |
|                         | F <sub>CRH</sub>                     | —                    | —         | —     | 12.25 | 12.5   | 12.75 | MHz   | When the main internal clock is used      |
|                         |                                      |                      |           |       | 9.8   | 10     | 10.2  | MHz   |   |
|                         |                                      |                      |           |       | 7.84  | 8      | 8.16  | MHz   |   |
|                         |                                      |                      |           |       | 0.98  | 1      | 1.02  | MHz   |   |
|                         | F <sub>CL</sub>                      | X0A, X1A             | —         | —     | —     | 32.768 | —     | kHz   | When the main oscillation circuit is used |
|                         |                                      |                      |           |       | —     | 32.768 | —     | kHz   | When the sub-external clock is used       |
|                         | F <sub>CRL</sub>                     | —                    | —         | —     | 50    | 100    | 200   | kHz   | When the sub-internal CR clock is used    |
| Clock cycle time        | t <sub>H CYL</sub>                   | X0, X1               | —         | 61.5  | —     | 1000   | ns    | When the main oscillation circuit is used   |   |
|                         |                                      | X0, HCLK1, HCLK2     | X1 open   | 83.4  | —     | 1000   | ns    | When the external clock is used   |   |
|                         |                                      | X0, X1, HCLK1, HCLK2 | —         | 30.8  | —     | 1000   | ns    |   |   |
|                         | t <sub>L CYL</sub>                   | X0A, X1A             | —         | —     | 30.5  | —      | μs    | When the subclock is used   |   |
| Input clock pulse width | t <sub>WH1</sub><br>t <sub>WL1</sub> | X0, HCLK1, HCLK2     | X1 open   | 33.4  | —     | —      | ns    | When the external clock is used, the duty ratio should range between 40% and 60%. |   |
|                         |                                      | X0, X1, HCLK1, HCLK2 | —         | 12.4  | —     | —      | ns    |   |   |
|                         | t <sub>WH2</sub><br>t <sub>WL2</sub> | X0A                  | —         | —     | 15.2  | —      | μs    |   |   |

| Parameter                           | Symbol             | Pin name            | Condition | Value |     |     | Unit | Remarks                                 |
|-------------------------------------|--------------------|---------------------|-----------|-------|-----|-----|------|---|
|                                     |                    |                     |           | Min   | Typ | Max |      |   |
| Input clock rise time and fall time | t <sub>CR</sub>    | X0, HCLK1, HCLK2    | X1 open   | —     | —   | 5   | ns   | When the external clock is used         |
|                                     | t <sub>CF</sub>    | X0, X1 HCLK1, HCLK2 | —         | —     | —   | 5   | ns   |   |
| Internal CR oscillation start time  | t <sub>CRHWK</sub> | —                   | —         | —     | —   | 80  | μs   | When the main internal CR clock is used |
|                                     | t <sub>CRLWK</sub> | —                   | —         | —     | —   | 10  | μs   | When the sub-internal CR clock is used  |

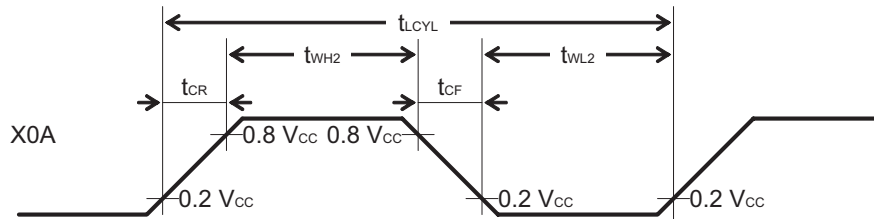
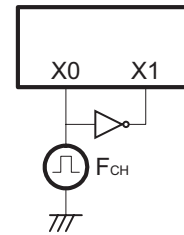
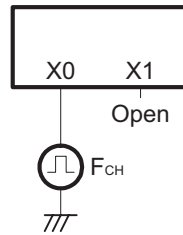
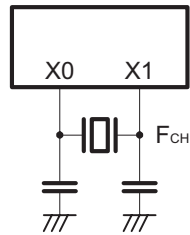


- Figure of main clock input port external connection

When a crystal oscillator or a ceramic oscillator is used

When the external clock is used (X1 is open)

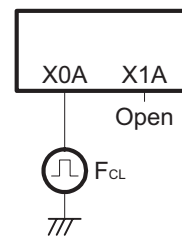
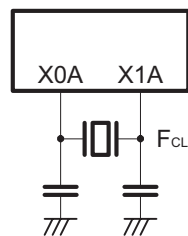
When the external clock is used



- Figure of subclock input port external connection

When a crystal oscillator or a ceramic oscillator is used

When the external clock is used



## (2) Source Clock/Machine Clock

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

| Parameter  | Symbol            | Pin name | Value  |     |        | Unit  | Remarks  |
|--|-------------------|----------|--------|-----|--------|---|--|
|  |                   |          | Min    | Typ | Max    |   |  |
| Source clock cycle time* <sup>1</sup><br>(clock before division)               | t <sub>SCLK</sub> | —        | 61.5   | —   | 2000   | ns  | When the main external clock is used<br>Min : F <sub>CH</sub> = 32.5 MHz, divided by 2<br>Max : F <sub>CH</sub> = 1 MHz, divided by 2            |
|  |                   |          | 80     | —   | 1000   | ns  | When the main CR clock is used<br>Min : F <sub>CRH</sub> = 12.5 MHz<br>Max : F <sub>CRH</sub> = 1 MHz  |
|  |                   |          | —      | 61  | —      | μs  | When the sub-oscillation clock is used<br>F <sub>CL</sub> = 32.768 kHz, divided by 2   |
|  |                   |          | —      | 20  | —      | μs  | When the sub-oscillation clock is used<br>F <sub>CRL</sub> = 100 kHz, divided by 2   |
| Source clock frequency   | F <sub>SP</sub>   | —        | 0.5    | —   | 16.25  | MHz   | When the main oscillation clock is used  |
|  |                   |          | 1      | —   | 12.5   | MHz   | When the main CR clock is used   |
|  | —                 |          | 16.384 | —   | kHz    | When the sub-oscillation clock is used                      |  |
|  | F <sub>SPL</sub>  |          | —      | 50  | —      | kHz   | When the sub-CR clock is used<br>F <sub>CRL</sub> = 100 kHz, divided by 2  |
| Machine clock cycle time* <sup>2</sup><br>(minimum instruction execution time) | t <sub>MCLK</sub> | —        | 61.5   | —   | 32000  | ns  | When the main oscillation clock is used<br>Min : F <sub>SP</sub> = 16.25 MHz, no division<br>Max : F <sub>SP</sub> = 0.5 MHz, divided by 16      |
|  |                   |          | 80     | —   | 16000  | ns  | When the main CR clock is used<br>Min : F <sub>SP</sub> = 12.5 MHz<br>Max : F <sub>SP</sub> = 1 MHz, divided by 16                               |
|  |                   |          | 61     | —   | 976.5  | μs  | When the sub-oscillation clock is used<br>Min : F <sub>SPL</sub> = 16.393 kHz, no division<br>Max : F <sub>SPL</sub> = 16.393 kHz, divided by 16 |
|  |                   |          | 20     | —   | 320    | μs  | When the sub-CR clock is used<br>Min : F <sub>SPL</sub> = 50 kHz, no division<br>Max : F <sub>SPL</sub> = 50 kHz, divided by 16                  |
| Machine clock frequency  | F <sub>MP</sub>   | —        | 0.031  | —   | 16.25  | MHz   | When the main oscillation clock is used  |
|  |                   |          | 0.0625 | —   | 12.5   | MHz   | When the main CR clock is used   |
|  | F <sub>MPL</sub>  |          | 1.024  | —   | 16.384 | kHz   | When the sub-oscillation clock is used   |
|  | 3.125             |          | —      | 50  | kHz    | When the sub-CR clock is used<br>F <sub>CRL</sub> = 100 kHz |  |

\*1: This is the clock before it is divided according to the division ratio set by the machine clock division ratio selection bits (SYCC : DIV1 and DIV0) . This source clock is divided to become a machine clock according to the division ratio set by the machine clock division ratio selection bits (SYCC : DIV1 and DIV0) . In addition, a source clock can be selected from the following.

- Main clock divided by 2
- Main CR clock
- Subclock divided by 2
- Sub-CR clock divided by 2

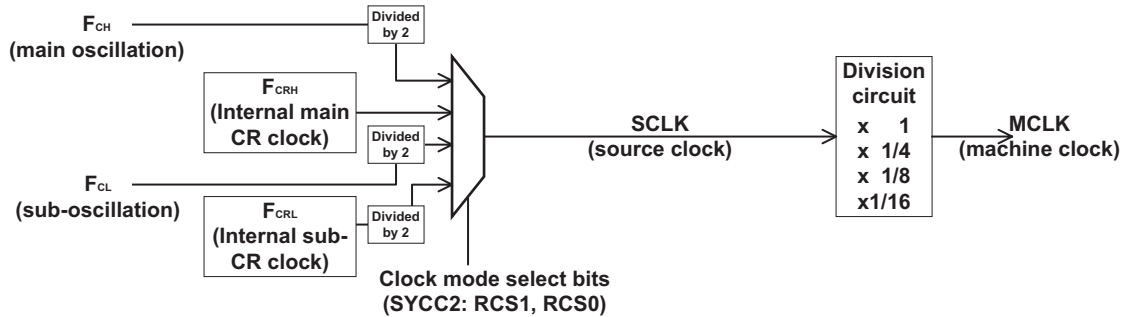
\*2: This is the operating clock of the microcontroller. A machine clock can be selected from the following.

- Source clock (no division)

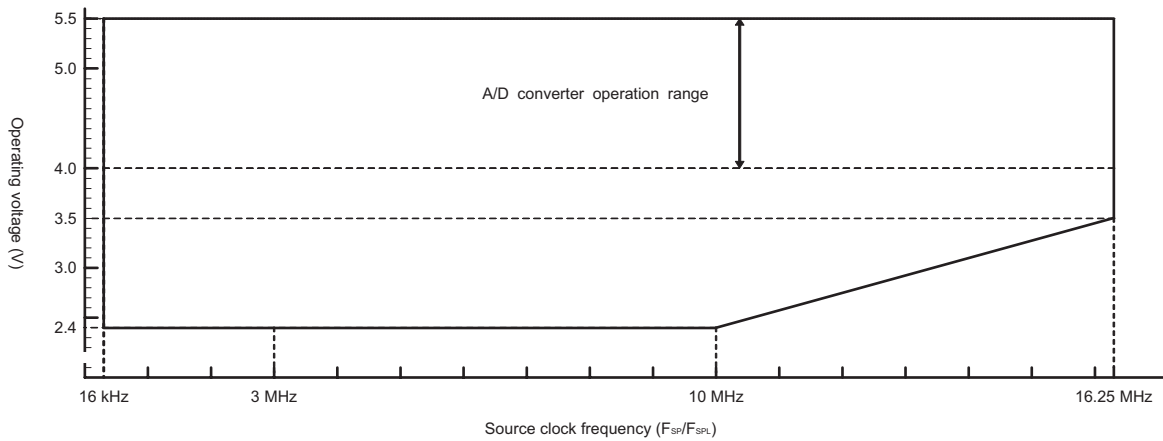


- Source clock divided by 4
- Source clock divided by 8
- Source clock divided by 16

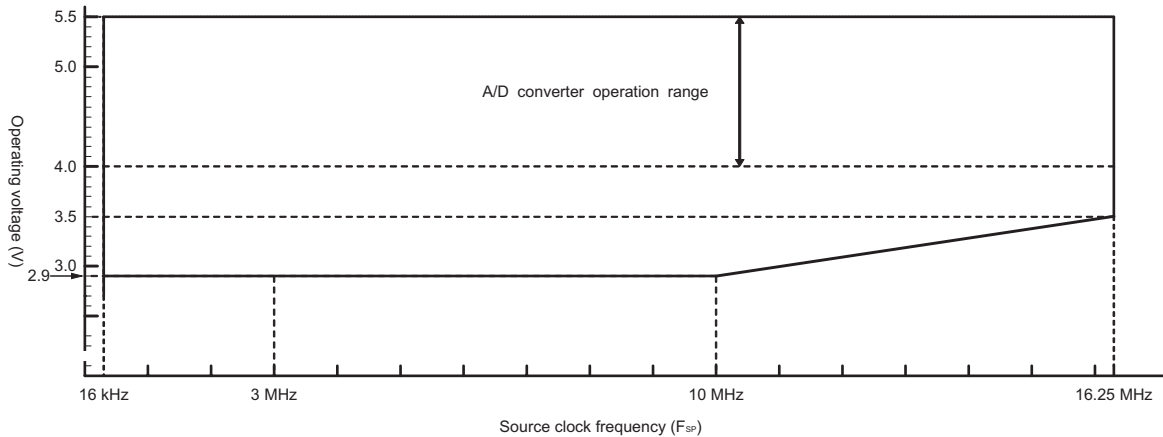
- Schematic diagram of the clock generation block



- Operating voltage - Operating frequency (When  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )
  - MB95200H/210H (without the on-chip debug function)



- Operating voltage - Operating frequency (When  $T_A = +5\text{ }^\circ\text{C}$  to  $+35\text{ }^\circ\text{C}$ )
  - MB95200H/210H (with the on-chip debug function)



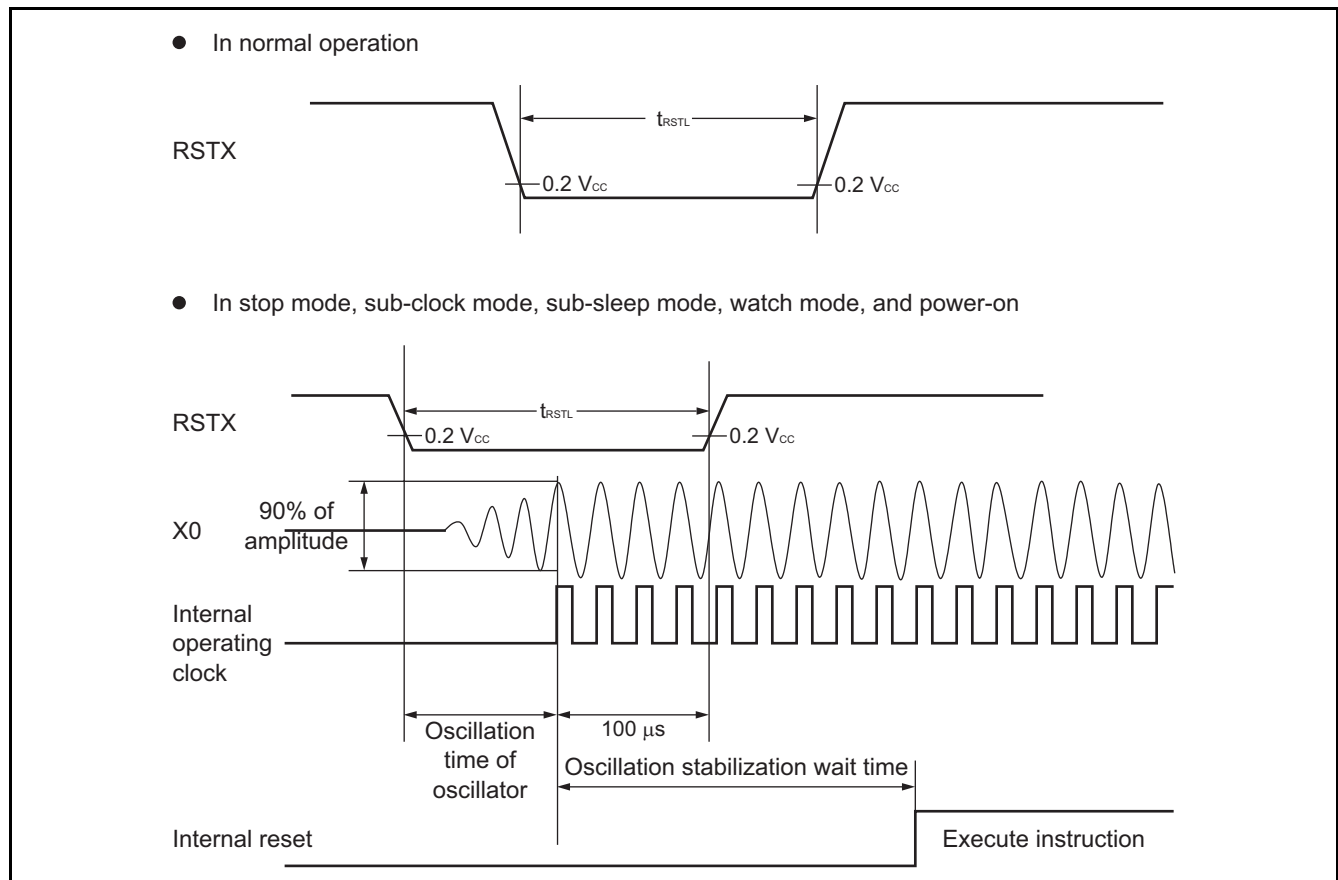
(3) External Reset

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

| Parameter                  | Symbol     | Value  |     | Unit          | Remarks   |
|----------------------------|------------|--|-----|---------------|---|
|                            |            | Min  | Max |               |   |
| RSTX "L" level pulse width | $t_{RSTL}$ | $2 t_{MCLK}^{*1}$                                      | —   | ns            | In normal operation   |
|                            |            | Oscillation time of the oscillator <sup>*2</sup> + 100 | —   | $\mu\text{s}$ | In stop mode, subclock mode, sub-sleep mode, and watch mode |
|                            |            | 100  | —   | $\mu\text{s}$ | In timebase timer mode                                      |

\*1 : See “ (2) Source Clock/Machine Clock” for  $t_{MCLK}$ .

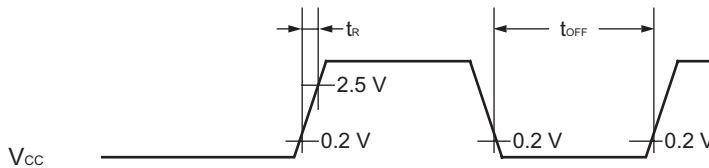
\*2 : The oscillation time of an oscillator is the time that the amplitude reaches 90%. The crystal oscillator has an oscillation time of between several ms and tens of ms. The ceramic oscillator has an oscillation time of between hundreds of  $\mu\text{s}$  and several ms. The external clock has an oscillation time of 0 ms. The CR oscillator clock has an oscillation time of between several  $\mu\text{s}$  and several ms.



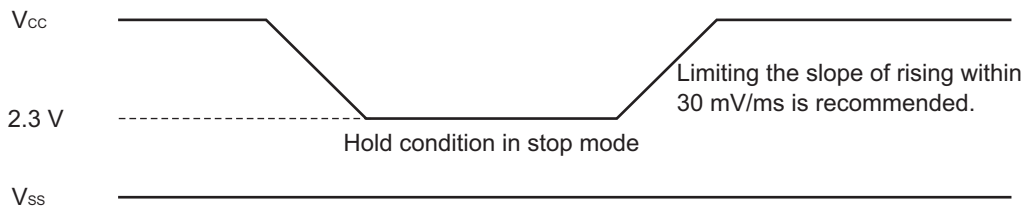
## (4) Power-on Reset

( $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

| Parameter                | Symbol    | Condition | Value |     | Unit | Remarks                  |
|--------------------------|-----------|-----------|-------|-----|------|--------------------------|
|                          |           |           | Min   | Max |      |                          |
| Power supply rising time | $t_R$     | —         | —     | 50  | ms   |                          |
| Power supply cutoff time | $t_{OFF}$ | —         | 1     | —   | ms   | Wait time until power-on |



Note: A sudden change of power supply voltage may activate the power-on reset function. When changing the power supply voltage during the operation, set the slope of rising to within 30 mV/ms as shown below.



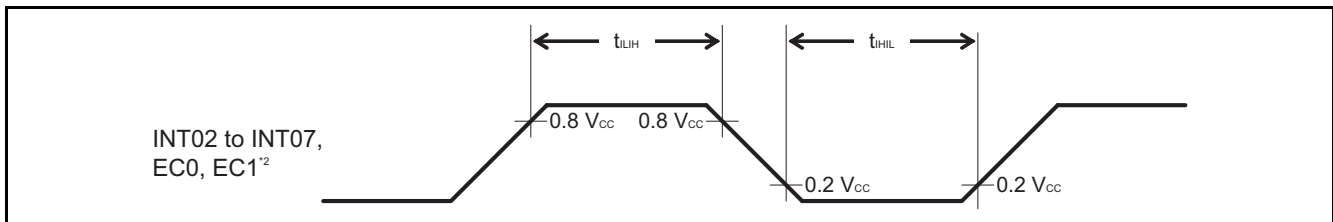
(5) Peripheral Input Timing

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

| Parameter                        | Symbol   | Pin name                               | Value             |     | Unit |
|----------------------------------|----------|--|-------------------|-----|------|
|                                  |          |  | Min               | Max |      |
| Peripheral input "H" pulse width | $t_{LH}$ | INT02 to INT07, EC0, EC1 <sup>*2</sup> | $2 t_{MCLK}^{*1}$ | —   | ns   |
| Peripheral input "L" pulse width | $t_{HL}$ |  | $2 t_{MCLK}^{*1}$ | —   | ns   |

\*1 : See " (2) Source Clock/Machine Clock" for  $t_{MCLK}$ .

\*2 : INT02, INT03, INT05, INT07 and EC1 are available in MB95F204H/F203H/F202H/F204K/F203K/F202K.



## (6) LIN-UART Timing (Available in MB95F204H/F203H/F202H/F204K/F203K/F202K only)

Sampling is executed at the rising edge of the sampling clock\*1, and serial clock delay is disabled\*2.  
 (ESCR register : SCES bit = 0, ECCR register : SCDE bit = 0)

(V<sub>CC</sub> = 5.0 V ± 10%, AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V, T<sub>A</sub> = - 40 °C to + 85 °C)

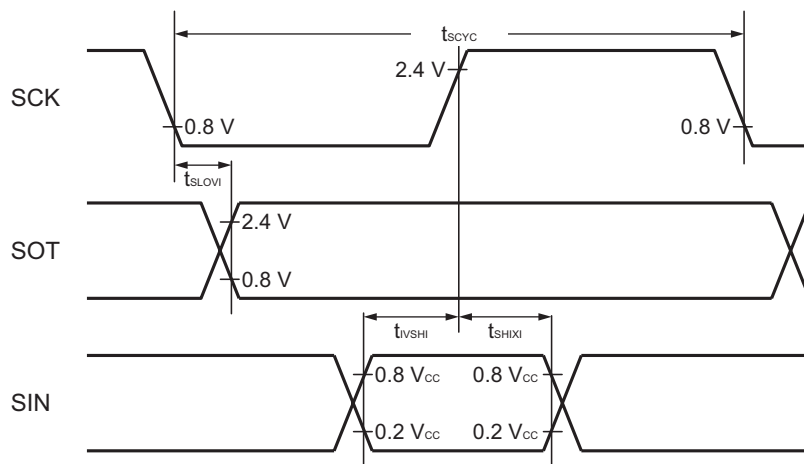
| Parameter                    | Symbol             | Pin name | Condition  | Value                                   |                             | Unit |
|------------------------------|--------------------|----------|--|---|-----------------------------|------|
|                              |                    |          |  | Min                                     | Max                         |      |
| Serial clock cycle time      | t <sub>SCYC</sub>  | SCK      | Internal clock<br>operation output pin :<br>C <sub>L</sub> = 80 pF + 1 TTL | 5 t <sub>MCLK</sub> *3                  | —                           | ns   |
| SCK ↓ → SOT delay time       | t <sub>SLOVI</sub> | SCK, SOT |  | - 95                                    | + 95                        | ns   |
| Valid SIN → SCK ↑            | t <sub>IVSHI</sub> | SCK, SIN |  | t <sub>MCLK</sub> *3 + 190              | —                           | ns   |
| SCK ↑ → valid SIN hold time  | t <sub>SHIXI</sub> | SCK, SIN |  | 0                                       | —                           | ns   |
| Serial clock “L” pulse width | t <sub>SLSH</sub>  | SCK      | External clock<br>operation output pin :<br>C <sub>L</sub> = 80 pF + 1 TTL | 3 t <sub>MCLK</sub> *3 - t <sub>R</sub> | —                           | ns   |
| Serial clock “H” pulse width | t <sub>SHSL</sub>  | SCK      |  | t <sub>MCLK</sub> *3 + 95               | —                           | ns   |
| SCK ↓ → SOT delay time       | t <sub>SLOVE</sub> | SCK, SOT |  | —                                       | 2 t <sub>MCLK</sub> *3 + 95 | ns   |
| Valid SIN → SCK ↑            | t <sub>IVSHE</sub> | SCK, SIN |  | 190                                     | —                           | ns   |
| SCK ↑ → valid SIN hold time  | t <sub>SHIXE</sub> | SCK, SIN |  | t <sub>MCLK</sub> *3 + 95               | —                           | ns   |
| SCK fall time                | t <sub>F</sub>     | SCK      |  | —                                       | 10                          | ns   |
| SCK rise time                | t <sub>R</sub>     | SCK      |  | —                                       | 10                          | ns   |

\*1: There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

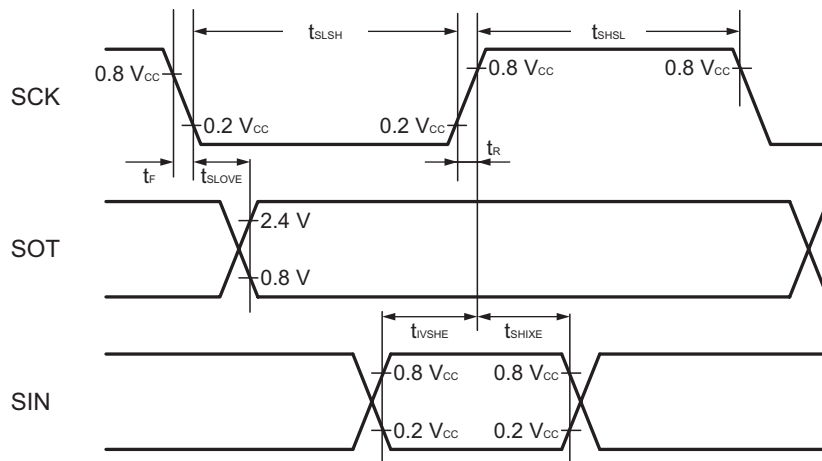
\*2: The serial clock delay function is a function used to delay the output signal of the serial clock for half the clock.

\*3: See “ (2) Source Clock/Machine Clock” for t<sub>MCLK</sub>.

● Internal shift clock mode



● External shift clock mode



Sampling is executed at the falling edge of the sampling clock\*1, and serial clock delay is disabled\*2.  
(ESCR register : SCES bit = 1, ECCR register : SCDE bit = 0)

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

| Parameter                              | Symbol      | Pin name | Condition   | Value                   |                        | Unit |
|--|-------------|----------|---|-------------------------|------------------------|------|
|  |             |          |   | Min                     | Max                    |      |
| Serial clock cycle time                | $t_{SCYC}$  | SCK      | Internal clock<br>operation output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL}$ | $5 t_{MCLK}^{*3}$       | —                      | ns   |
| SCK $\uparrow$ → SOT delay time        | $t_{SHOVI}$ | SCK, SOT |   | - 95                    | + 95                   | ns   |
| Valid SIN → SCK $\downarrow$           | $t_{IVSLI}$ | SCK, SIN |   | $t_{MCLK}^{*3} + 190$   | —                      | ns   |
| SCK $\downarrow$ → valid SIN hold time | $t_{SLIXI}$ | SCK, SIN |   | 0                       | —                      | ns   |
| Serial clock “H” pulse width           | $t_{SHSL}$  | SCK      | External clock<br>operation output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL}$ | $3 t_{MCLK}^{*3} - t_R$ | —                      | ns   |
| Serial clock “L” pulse width           | $t_{SLSH}$  | SCK      |   | $t_{MCLK}^{*3} + 95$    | —                      | ns   |
| SCK $\uparrow$ → SOT delay time        | $t_{SHOVE}$ | SCK, SOT |   | —                       | $2 t_{MCLK}^{*3} + 95$ | ns   |
| Valid SIN → SCK $\downarrow$           | $t_{IVSLE}$ | SCK, SIN |   | 190                     | —                      | ns   |
| SCK $\downarrow$ → valid SIN hold time | $t_{SLIXE}$ | SCK, SIN |   | $t_{MCLK}^{*3} + 95$    | —                      | ns   |
| SCK fall time                          | $t_F$       | SCK      |   | —                       | 10                     | ns   |
| SCK rise time                          | $t_R$       | SCK      |   | —                       | 10                     | ns   |

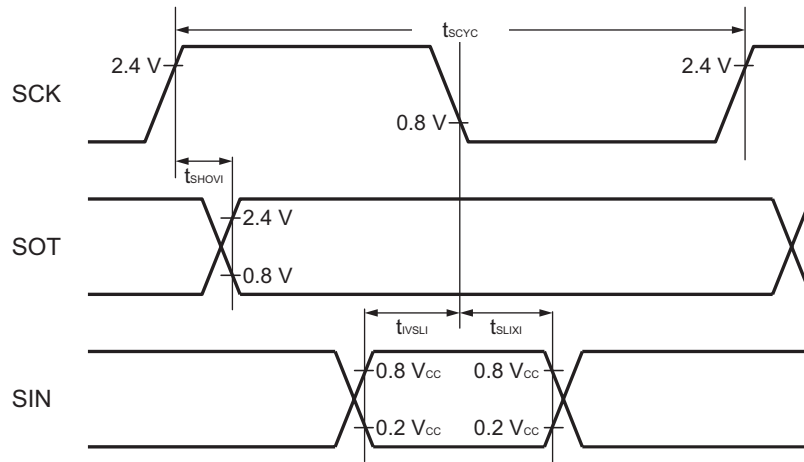
\*1: There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

\*2: The serial clock delay function is a function used to delay the output signal of the serial clock for half the clock.

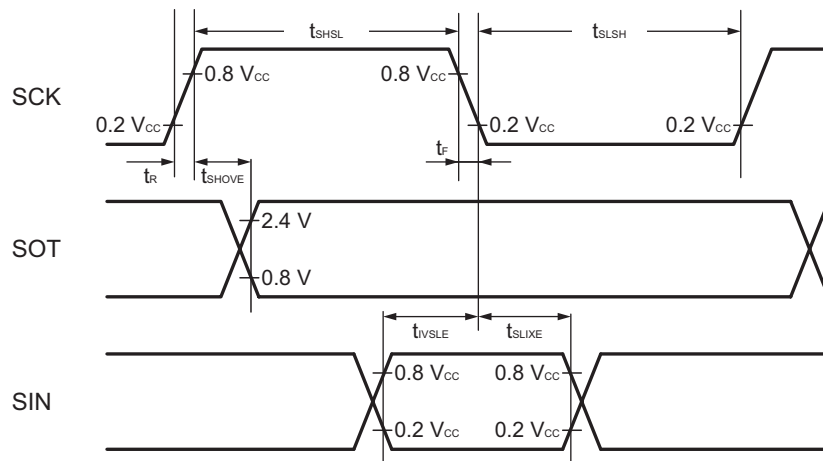
\*3: See “ (2) Source Clock/Machine Clock” for  $t_{MCLK}$ .



● Internal shift clock mode



● External shift clock mode



Sampling is executed at the rising edge of the sampling clock\*1, and serial clock delay is enabled\*2.  
 (ESCR register : SCES bit = 0, ECCR register : SCDE bit = 1)

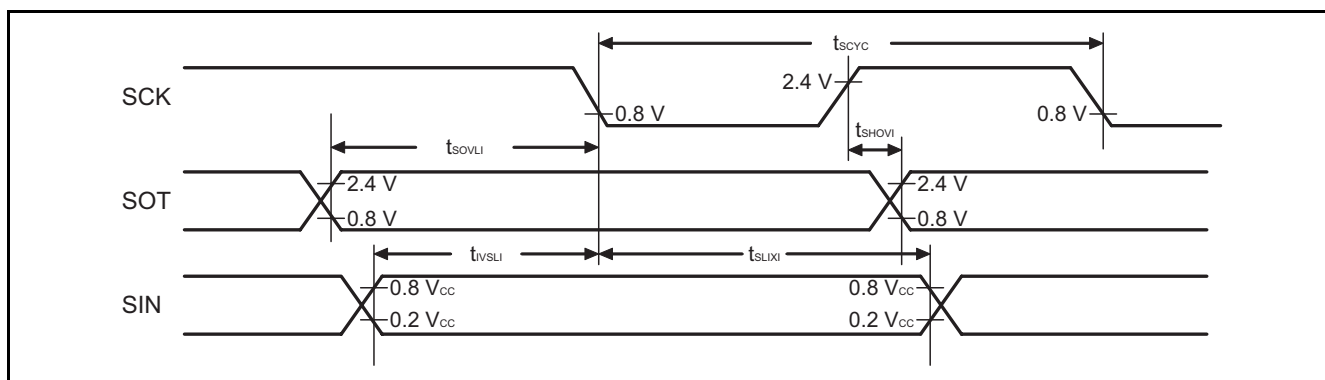
( $V_{CC} = 5.0 \text{ V} \pm 10\%$ ,  $V_{SS} = 0.0 \text{ V}$ ,  $T_A = -40 \text{ }^\circ\text{C}$  to  $+85 \text{ }^\circ\text{C}$ )

| Parameter                              | Symbol      | Pin name | Condition   | Value                 |                   | Unit |
|--|-------------|----------|---|-----------------------|-------------------|------|
|  |             |          |   | Min                   | Max               |      |
| Serial clock cycle time                | $t_{SCYC}$  | SCK      | Internal clock<br>operation output pin :<br>$C_L = 80 \text{ pF} + 1 \text{ TTL}$ | $5 t_{MCLK}^{*3}$     | —                 | ns   |
| SCK $\uparrow$ → SOT delay time        | $t_{SHOVI}$ | SCK, SOT |   | -95                   | +95               | ns   |
| Valid SIN → SCK $\downarrow$           | $t_{VSLI}$  | SCK, SIN |   | $t_{MCLK}^{*3} + 190$ | —                 | ns   |
| SCK $\downarrow$ → valid SIN hold time | $t_{SLIXI}$ | SCK, SIN |   | 0                     | —                 | ns   |
| SOT → SCK $\downarrow$ delay time      | $t_{SOVLI}$ | SCK, SOT |   | —                     | $4 t_{MCLK}^{*3}$ | ns   |

\*1: There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

\*2: The serial clock delay function is a function that delays the output signal of the serial clock for half clock.

\*3: See “(2) Source Clock/Machine Clock” for  $t_{MCLK}$ .



Sampling is executed at the falling edge of the sampling clock\*1, and serial clock delay is enabled\*2.  
 (ESCR register : SCES bit = 1, ECCR register : SCDE bit = 1)

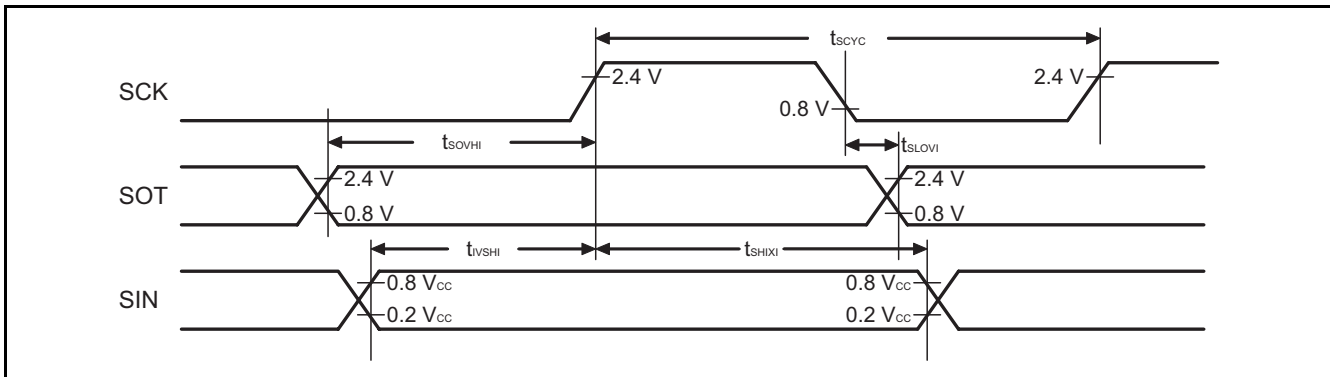
( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

| Parameter                   | Symbol      | Pin name | Condition   | Value                 |                    | Unit |
|-----------------------------|-------------|----------|---|-----------------------|--------------------|------|
|                             |             |          |   | Min                   | Max                |      |
| Serial clock cycle time     | $t_{SCYC}$  | SCK      | Internal clock<br>operating output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL}$ | $5\ t_{MCLK}^{*3}$    | —                  | ns   |
| SCK ↓ → SOT delay time      | $t_{SLOVI}$ | SCK, SOT |   | - 95                  | + 95               | ns   |
| Valid SIN → SCK ↑           | $t_{VSHI}$  | SCK, SIN |   | $t_{MCLK}^{*3} + 190$ | —                  | ns   |
| SCK ↑ → valid SIN hold time | $t_{SHIXI}$ | SCK, SIN |   | 0                     | —                  | ns   |
| SOT → SCK ↑ delay time      | $t_{SOVHI}$ | SCK, SOT |   | —                     | $4\ t_{MCLK}^{*3}$ | ns   |

\*1: There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

\*2: The serial clock delay function is a function that delays the output signal of the serial clock for half clock.

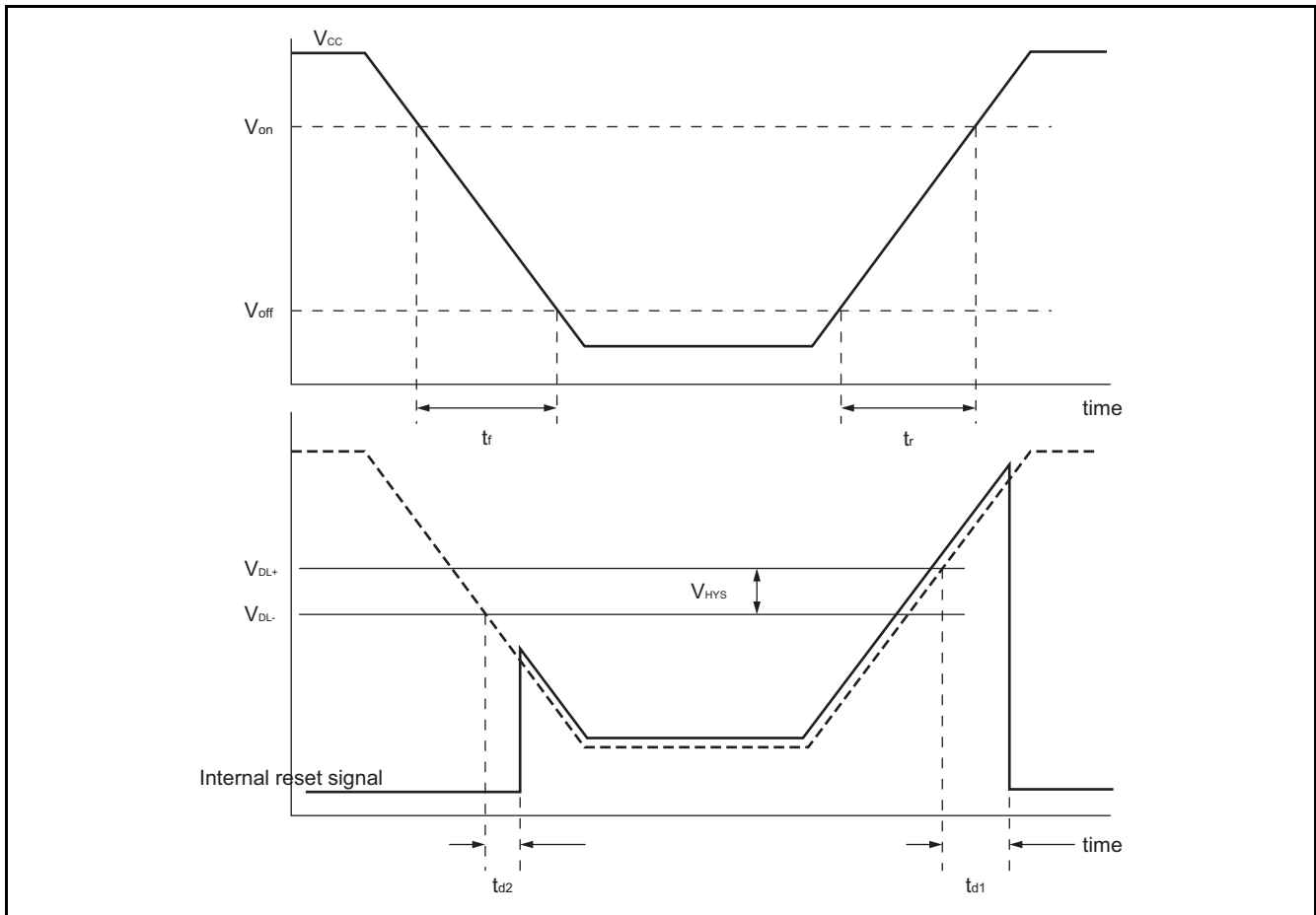
\*3: See “(2) Source Clock/Machine Clock” for  $t_{MCLK}$ .



## (7) Low-voltage Detection

( $V_{SS} = 0.0 \text{ V}$ ,  $T_A = -40 \text{ }^\circ\text{C}$  to  $+85 \text{ }^\circ\text{C}$ )

| Parameter   | Symbol    | Value |      |      | Unit          | Remarks   |
|---|-----------|-------|------|------|---------------|---|
|   |           | Min   | Typ  | Max  |               |   |
| Release voltage   | $V_{DL+}$ | 2.52  | 2.7  | 2.88 | V             | At power supply rise  |
| Detection voltage                                       | $V_{DL-}$ | 2.42  | 2.6  | 2.78 | V             | At power supply fall  |
| Hysteresis width  | $V_{HYS}$ | 70    | 100  | —    | mV            |   |
| Power supply start voltage                              | $V_{off}$ | —     | —    | 2.3  | V             |   |
| Power supply end voltage                                | $V_{on}$  | 4.9   | —    | —    | V             |   |
| Power supply voltage change time (at power supply rise) | $t_r$     | 1     | —    | —    | $\mu\text{s}$ | Slope of power supply that the reset release signal generates                                   |
|   |           | —     | 3000 | —    | $\mu\text{s}$ | Slope of power supply that the reset release signal generates within the rating ( $V_{DL+}$ )   |
| Power supply voltage change time (at power supply fall) | $t_r$     | 300   | —    | —    | $\mu\text{s}$ | Slope of power supply that the reset detection signal generates                                 |
|   |           | —     | 300  | —    | $\mu\text{s}$ | Slope of power supply that the reset detection signal generates within the rating ( $V_{DL-}$ ) |
| Reset release delay time                                | $t_{d1}$  | —     | —    | 300  | $\mu\text{s}$ |   |
| Reset detection delay time                              | $t_{d2}$  | —     | —    | 20   | $\mu\text{s}$ |   |



## 5. A/D Converter

### (1) A/D Converter Electrical Characteristics

( $V_{CC} = 4.0\text{ V to }5.5\text{ V}$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C to }+85\text{ }^\circ\text{C}$ )

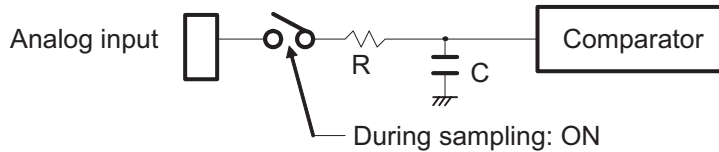
| Parameter                     | Symbol    | Value                     |                           |                           | Unit          | Remarks  |
|-------------------------------|-----------|---------------------------|---------------------------|---------------------------|---------------|--|
|                               |           | Min                       | Typ                       | Max                       |               |  |
| Resolution                    | —         | —                         | —                         | 10                        | bit           |  |
| Total error                   |           | - 3                       | —                         | + 3                       | LSB           |  |
| Linearity error               |           | - 2.5                     | —                         | + 2.5                     | LSB           |  |
| Differential linear error     |           | - 1.9                     | —                         | + 1.9                     | LSB           |  |
| Zero transition voltage       | $V_{OT}$  | $V_{SS} - 1.5\text{ LSB}$ | $V_{SS} + 0.5\text{ LSB}$ | $V_{SS} + 2.5\text{ LSB}$ | V             |  |
| Full-scale transition voltage | $V_{FST}$ | $V_{CC} - 4.5\text{ LSB}$ | $V_{CC} - 2\text{ LSB}$   | $V_{CC} + 0.5\text{ LSB}$ | V             |  |
| Compare time                  | —         | 0.9                       | —                         | 16500                     | $\mu\text{s}$ | $4.5\text{ V} \leq V_{CC} \leq 5.5\text{ V}$   |
|                               |           | 1.8                       | —                         | 16500                     | $\mu\text{s}$ | $4.0\text{ V} \leq V_{CC} < 4.5\text{ V}$  |
| Sampling time                 | —         | 0.6                       | —                         | $\infty$                  | $\mu\text{s}$ | $4.5\text{ V} \leq V_{CC} \leq 5.5\text{ V}$ ,<br>with external impedance < 5.4 k $\Omega$ |
|                               |           | 1.2                       | —                         | $\infty$                  | $\mu\text{s}$ | $4.0\text{ V} \leq V_{CC} \leq 4.5\text{ V}$ ,<br>with external impedance < 2.4 k $\Omega$ |
| Analog input current          | $I_{AIN}$ | - 0.3                     | —                         | + 0.3                     | $\mu\text{A}$ |  |
| Analog input voltage          | $V_{AIN}$ | $V_{SS}$                  | —                         | $V_{CC}$                  | V             |  |

(2) Notes on Using the A/D Converter

• External impedance of analog input and its sampling time

- The A/D converter has a sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, considering the relationship between the external impedance and minimum sampling time, either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. In addition, if sufficient sampling time cannot be secured, connect a capacitor of about 0.1  $\mu\text{F}$  to the analog input pin.

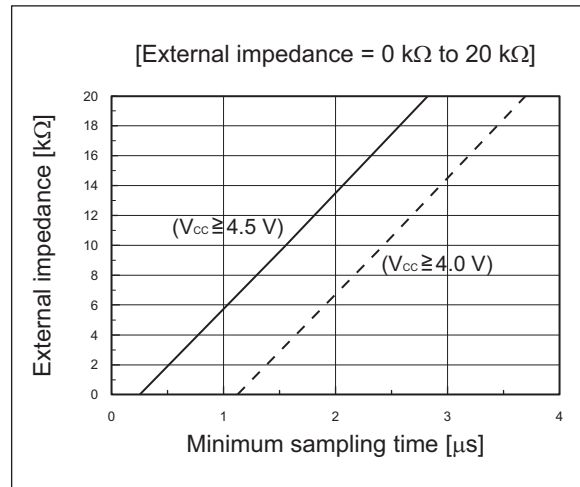
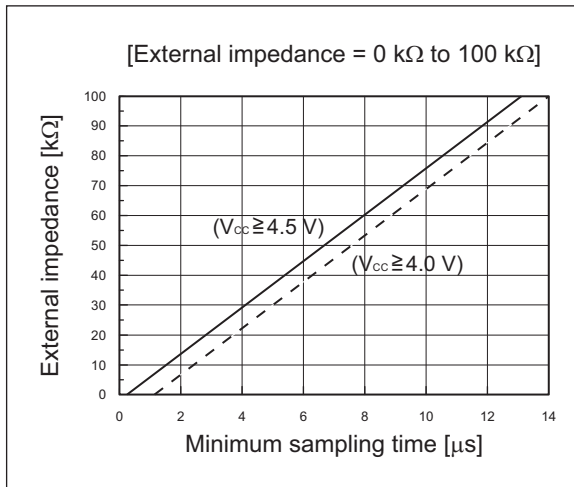
• Analog input equivalent circuit



4.5 V  $\leq$   $V_{cc} \leq$  5.5 V : R  $\approx$  1.95 k $\Omega$  (max), C  $\approx$  17 pF (max)  
 4.0 V  $\leq$   $V_{cc} <$  4.5 V : R  $\approx$  8.98 k $\Omega$  (max), C  $\approx$  17 pF (max)

Note: The values are reference values.

• Relationship between external impedance and minimum sampling time

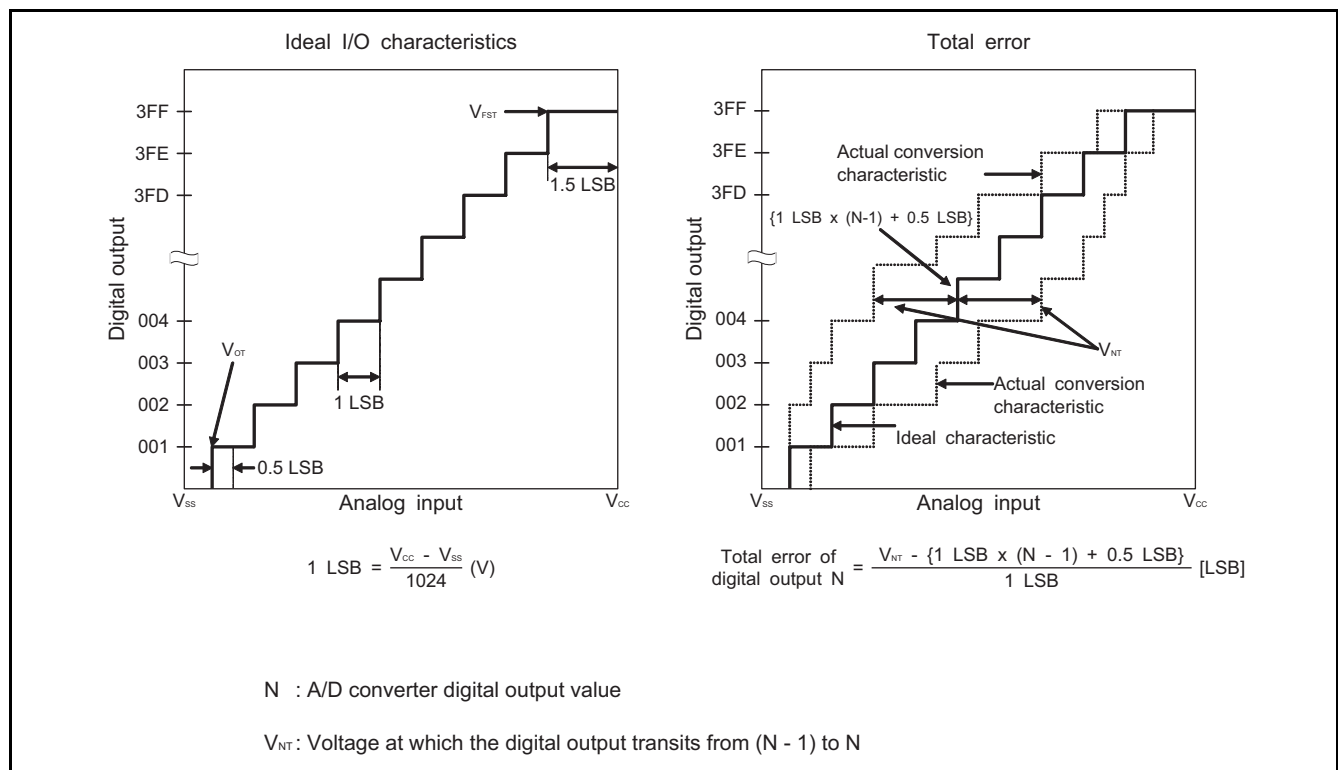


• A/D conversion error

As  $V_{cc} - V_{ssl}$  decreases, the A/D conversion error increases proportionately.

### (3) Definitions of A/D Converter Terms

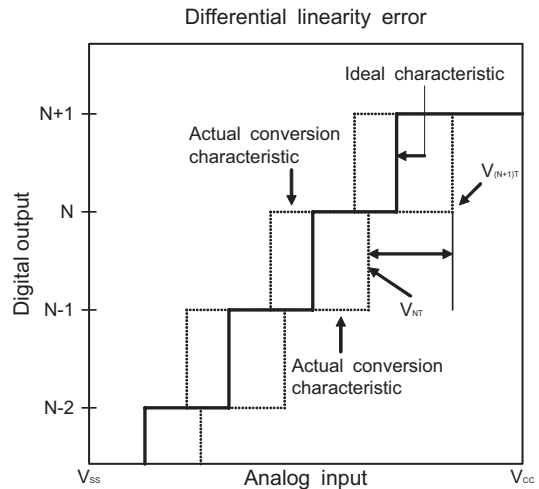
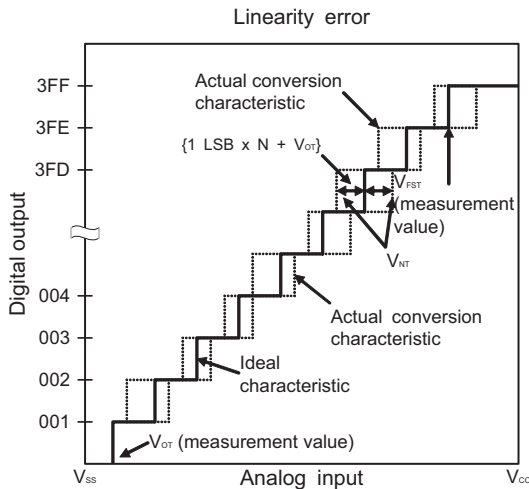
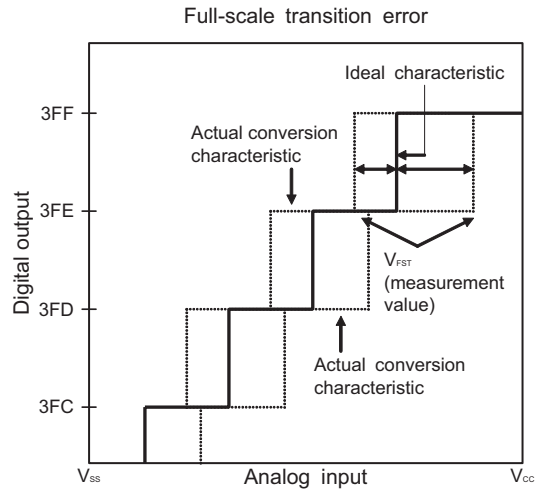
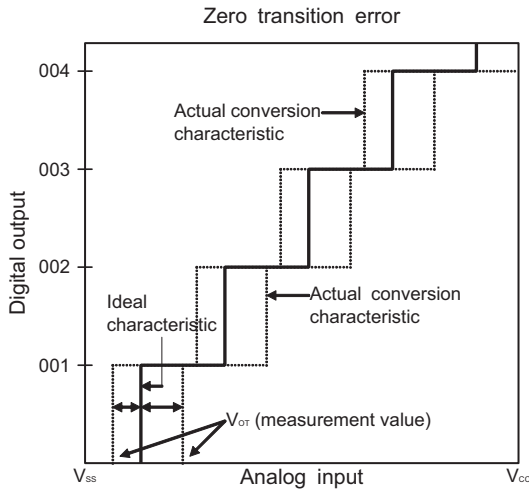
- Resolution  
It indicates the level of analog variation that can be distinguished by the A/D converter. When the number of bits is 10, analog voltage can be divided into  $2^{10} = 1024$ .
- Linearity error (unit : LSB)  
It indicates how much an actual conversion value deviates from the straight line connecting the zero transition point (“00 0000 0000” ← → “00 0000 0001”) of a device to the full-scale transition point (“11 1111 1111” ← → “11 1111 1110”) of the same device.
- Differential linear error (unit : LSB)  
It indicates how much the input voltage required to change the output code by 1 LSB deviates from an ideal value.
- Total error (unit: LSB)  
It indicates the difference between an actual value and a theoretical value. The error can be caused by a zero transition error, a full-scale transition errors, a linearity error, a quantum error, or noise.



(Continued)



(Continued)



$$\text{Linearity error of digital output } N = \frac{V_{NT} - \{1 \text{ LSB} \times N + V_{OT}\}}{1 \text{ LSB}}$$

$$\text{Differential linear error of digital output } N = \frac{V_{(N+1)T} - V_{NT}}{1 \text{ LSB}} - 1$$

N : A/D converter digital output value

$V_{NT}$ : voltage at which the digital output transits from (N - 1) to N

$V_{OT}$  (ideal value) =  $V_{SS} + 0.5 \text{ LSB}$  [V]

$V_{FST}$  (ideal value) =  $V_{CC} - 2.0 \text{ LSB}$  [V]

## 6. Flash Memory Program/Erase Characteristics

| Parameter                             | Value |        |      | Unit  | Remarks   |
|---------------------------------------|-------|--------|------|-------|---|
|                                       | Min   | Typ    | Max  |       |   |
| Chip erase time                       | —     | 1*1    | 15*2 | s     | 00 <sub>H</sub> programming time prior to erasure is excluded.              |
| Byte programming time                 | —     | 32     | 3600 | μs    | System-level overhead is excluded.  |
| Erase/program voltage                 | 9.5   | 10     | 10.5 | V     | The erase/program voltage must be applied to the RSTX pin in erase/program. |
| Erase/program cycle                   | —     | 100000 | —    | cycle |   |
| Power supply voltage at erase/program | 4.5   | —      | 5.5  | V     |   |
| Flash memory data retention time      | 20*3  | —      | —    | year  | Average T <sub>A</sub> = + 85 °C  |

\*1: T<sub>A</sub> = + 25 °C, V<sub>CC</sub> = 5.0 V, 100000 cycles

\*2: T<sub>A</sub> = + 85 °C, V<sub>CC</sub> = 4.5 V, 100000 cycles

\*3: This value is converted from the result of a technology reliability assessment. (The value is converted from the result of a high temperature accelerated test by using the Arrhenius equation with the average temperature being +85 °C) .

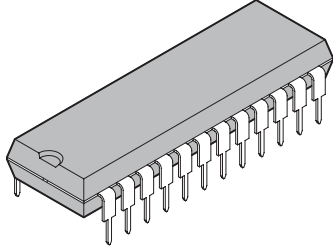
### ■ MASK OPTIONS

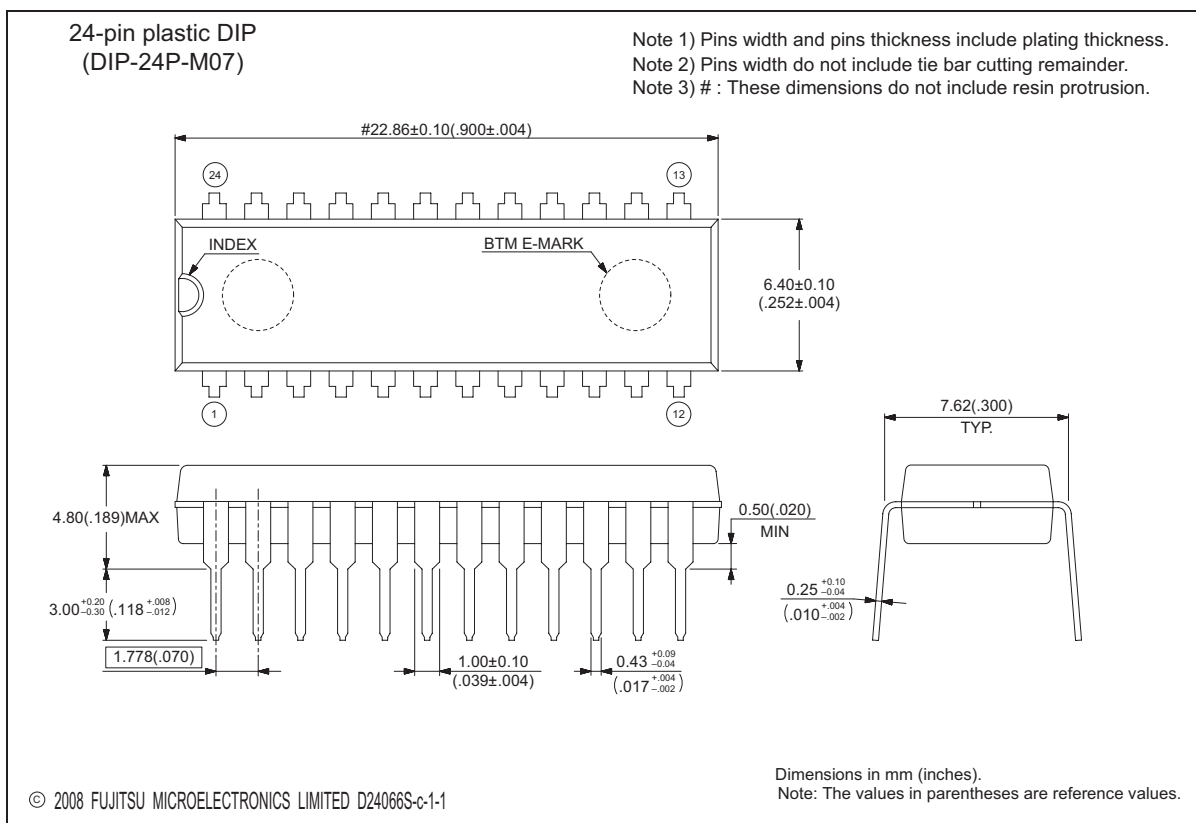
| No. | Part Number   | MB95F204H<br>MB95F203H<br>MB95F202H<br>MB95F214H<br>MB95F213H<br>MB95F212H | MB95F204K<br>MB95F203K<br>MB95F202K<br>MB95F214K<br>MB95F213K<br>MB95F212K |
|-----|---|--|--|
|     | Selection Method  | Setting disabled   | Setting disabled   |
| 1   | Low-voltage detection reset <ul style="list-style-type: none"> <li>• With low-voltage detection reset</li> <li>• Without low-voltage detection reset</li> </ul> | Without low-voltage detection reset  | With low-voltage detection reset   |
| 2   | Reset <ul style="list-style-type: none"> <li>• With dedicated reset input</li> <li>• Without dedicated reset input</li> </ul>                                   | With dedicated reset input   | Without dedicated reset input  |

### ■ ORDERING INFORMATION

| Part Number  | Package                              |
|--|--------------------------------------|
| MB95F204HP-G-SH-SNE2<br>MB95F204KP-G-SH-SNE2<br>MB95F203HP-G-SH-SNE2<br>MB95F203KP-G-SH-SNE2<br>MB95F202HP-G-SH-SNE2<br>MB95F202KP-G-SH-SNE2 | 24-pin plastic SDIP<br>(DIP-24P-M07) |
| MB95F204HPF-G-SNE2<br>MB95F204KPF-G-SNE2<br>MB95F203HPF-G-SNE2<br>MB95F203KPF-G-SNE2<br>MB95F202HPF-G-SNE2<br>MB95F202KPF-G-SNE2             | 20-pin plastic SOP<br>(FPT-20P-M09)  |
| MB95F214HPH-G-SNE2<br>MB95F214KPH-G-SNE2<br>MB95F213HPH-G-SNE2<br>MB95F213KPH-G-SNE2<br>MB95F212HPH-G-SNE2<br>MB95F212KPH-G-SNE2             | 8-pin plastic DIP<br>(DIP-8P-M03)    |
| MB95F214HPF-G-SNE2<br>MB95F214KPF-G-SNE2<br>MB95F213HPF-G-SNE2<br>MB95F213KPF-G-SNE2<br>MB95F212HPF-G-SNE2<br>MB95F212KPF-G-SNE2             | 8-pin plastic SOP<br>(FPT-8P-M08)    |

## ■ PACKAGE DIMENSIONS

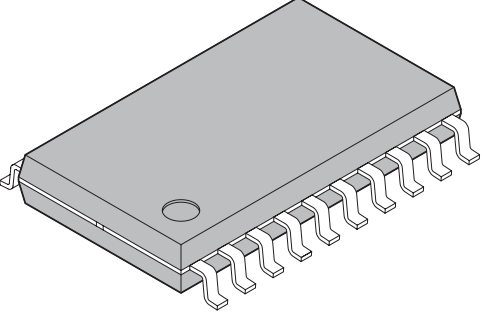
|  |                                |                    |  |
|--|--------------------------------|--------------------|--|
| <p>24-pin plastic DIP</p>  <p>(DIP-24P-M07)</p> | Lead pitch                     | 1.778 mm           |  |
|  | Package width × package length | 6.40 mm × 22.86 mm |  |
|  | Sealing method                 | Plastic mold       |  |
|  | Mounting height                | 4.80 mm Max        |  |
|  |                                |                    |  |
|  |                                |                    |  |
|  |                                |                    |  |

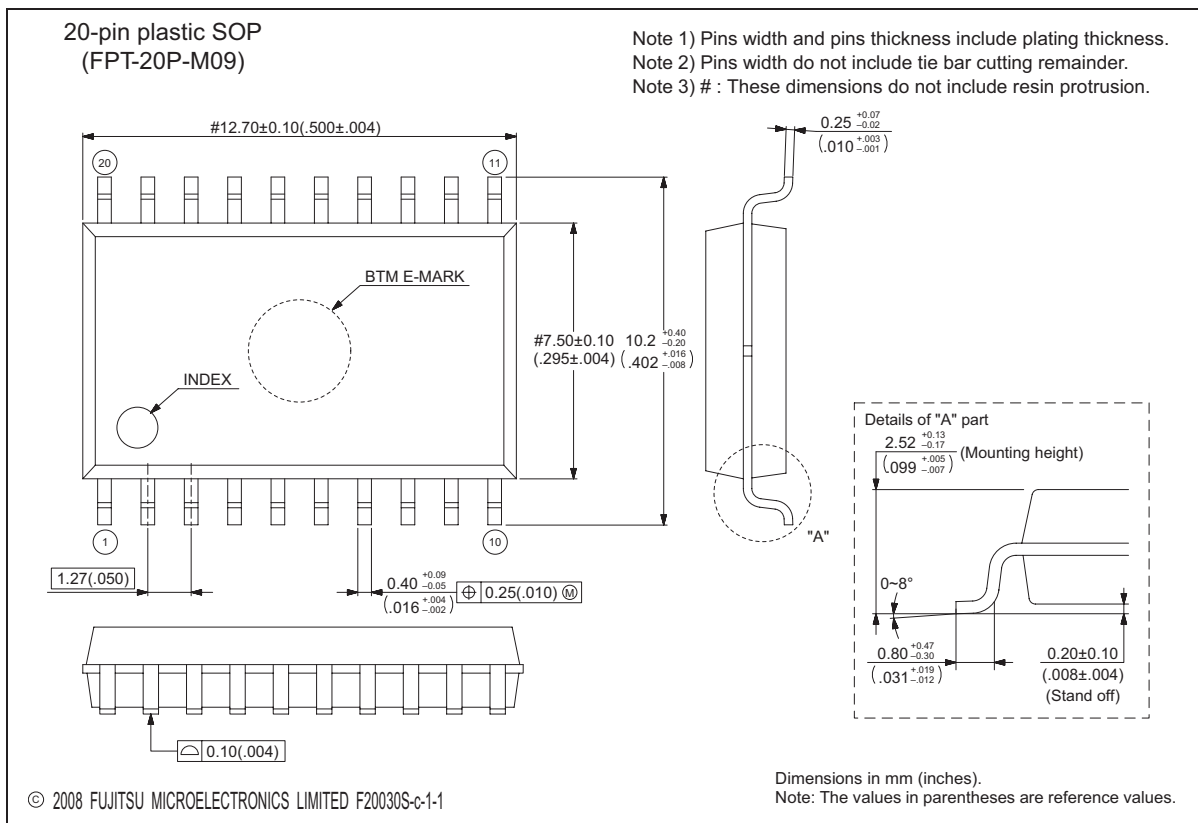


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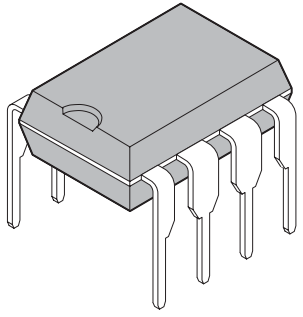
|  |                                |                    |
|--|--------------------------------|--------------------|
| <p>20-pin plastic SOP</p>  <p>(FPT-20P-M09)</p> | Lead pitch                     | 1.27 mm            |
|  | Package width × package length | 7.50 mm × 12.70 mm |
|  | Lead shape                     | Gullwing           |
|  | Lead bend direction            | Normal bend        |
|  | Sealing method                 | Plastic mold       |
|  | Mounting height                | 2.65 mm Max        |
|  |                                |                    |

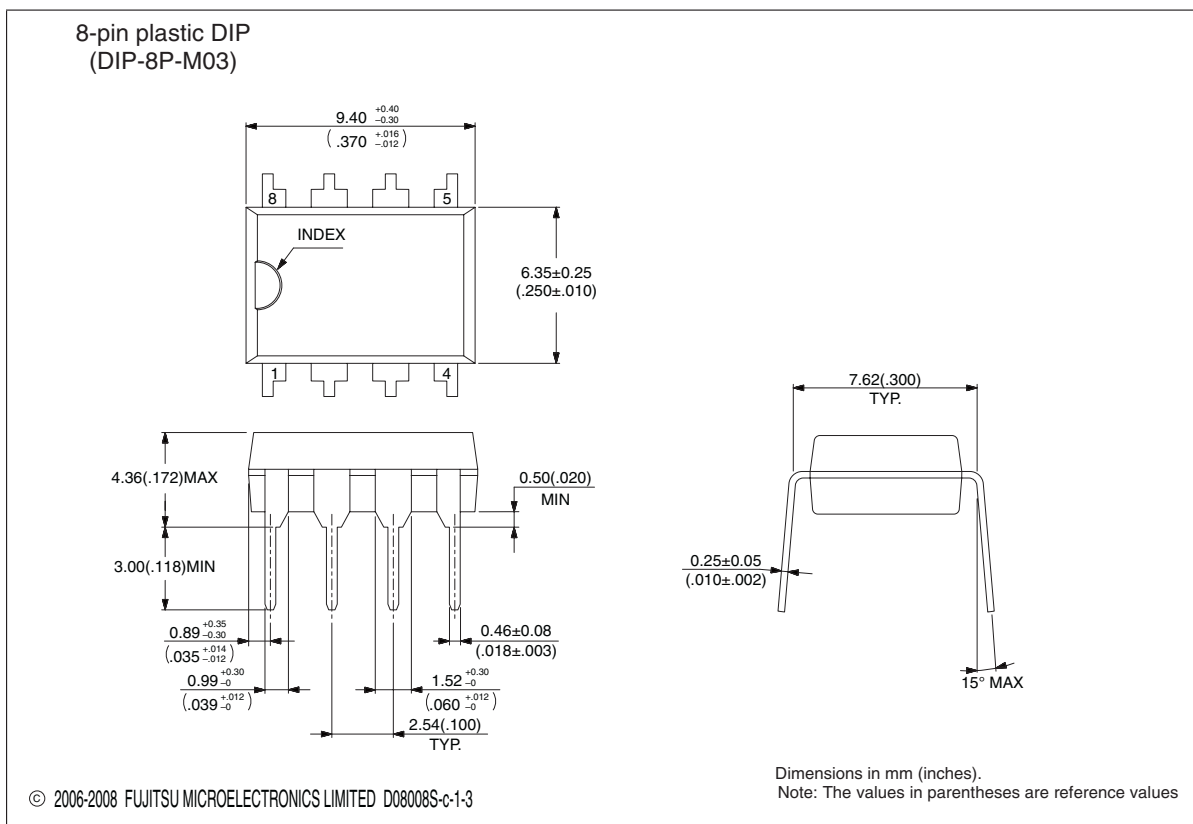


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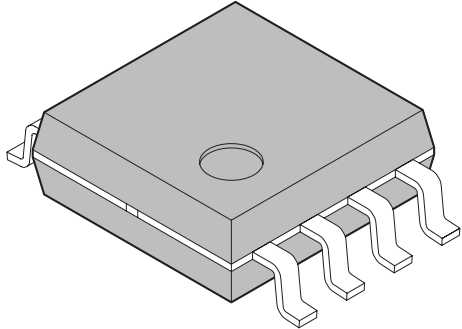
|  |                |              |
|--|----------------|--------------|
| <p>8-pin plastic DIP</p>  <p>(DIP-8P-M03)</p> | Lead pitch     | 2.54 mm      |
|  | Sealing method | Plastic mold |
|  |                |              |
|  |                |              |
|  |                |              |
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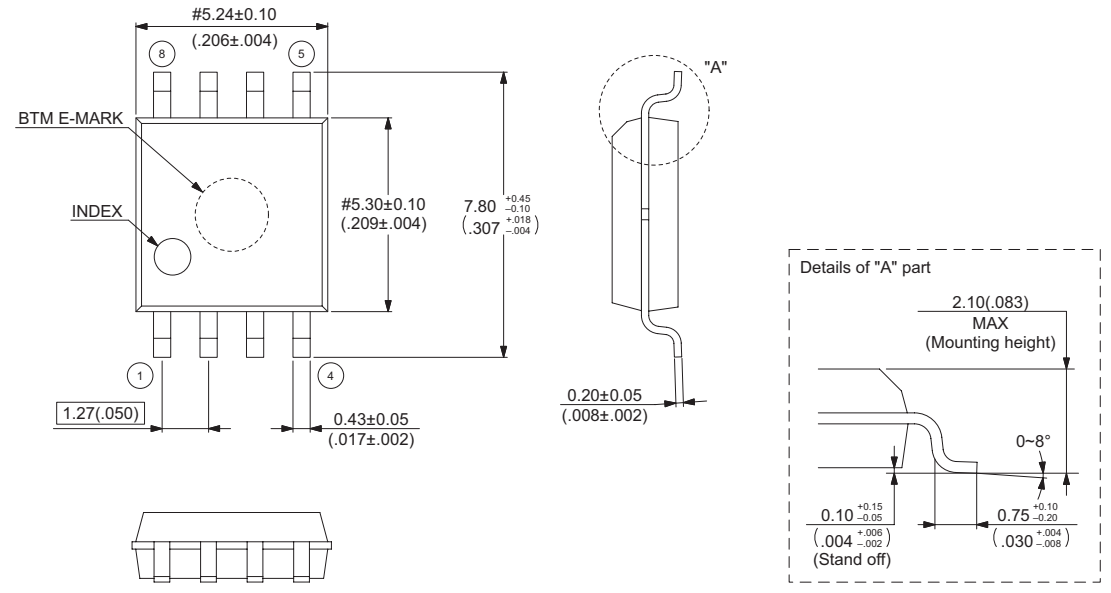
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|  |                                |                   |
|--|--------------------------------|-------------------|
| <p>8-pin plastic SOP</p>  <p>(FPT-8P-M08)</p> | Lead pitch                     | 1.27 mm           |
|  | Package width × package length | 5.30 mm × 5.24 mm |
|  | Lead shape                     | Gullwing          |
|  | Lead bend direction            | Normal bend       |
|  | Sealing method                 | Plastic mold      |
|  | Mounting height                | 2.10 mm Max       |
|  |                                |                   |

8-pin plastic SOP (FPT-8P-M08)

Note 1) Pins width and pins thickness include plating thickness.  
 Note 2) Pins width do not include tie bar cutting remainder.  
 Note 3) # : These dimensions do not include resin protrusion.



Dimensions in mm (inches).  
 Note: The values in parentheses are reference values.

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